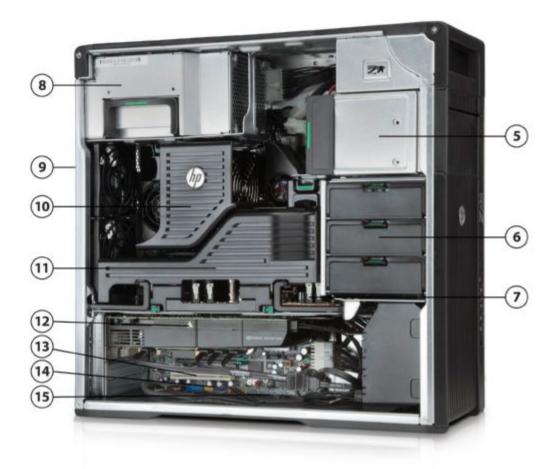
Overview



- 1. 2 External 5.25" Bays (shown with optional slot-load optical drive)
- 2. Power Button
- 3. HDD Activity LED
- 4. Front I/O: 1 USB 2.0, 2 USB 3.0, 1 Headphone, 1 Microphone, 1 1394a



Overview



- 5. 2 External 5.25" Bays
- 6. 3 Internal 3.5" Bays
- 7. 12 DIMM Slots for DDR3 ECC Memory
- 8. 800W, 90% Efficient Power Supply
- Rear I/O: Rear Power Button & LED, PS/2 Ports, 1 1394a, 4 USB 2.0, 2 USB 3.0, 2 RJ-45 to Integrated GbE, 1 Audio Line In, 1 Audio Line Out, 1 Microphone
- Intel Xeon Processors E5-1600 family or E5-2600 family

- 11. 2nd CPU & Memory Module
- 12. 2 PCle x16 Gen3 Slots
- 13. 1 PCle x8 Gen3, 1 PCle x8(x4) Gen2, 1 PCle x4(x1) Gen2, 1 PCl Slot
- 14. 6 Internal USB 2.0 Ports
- 15. 10 SATA Ports

Form Factor	Minitower					
Operating Systems	Preinstalled:					
	 Genuine Windows 7® Ultimate 64-bit* Genuine Windows 7® Professional 64-bit* Genuine Windows 7® Professional 32-bit* HP Installer Kit for Linux (includes drivers for 64-bit OS versions of RHEL 5 & 6 and SUSE 					
	Linux Enterprise Desktop 11) Red Hat Enterprise Linux Desktop (Preinstall NOT available; 1 year paper license only)					



Overview

Supported:

- Genuine Windows® 7 Enterprise 32/64
- SUSE Linux Enterprise Desktop 11

Notes: For detailed OS/hardware support information for Linux, see:

http://www.hp.com/support/linux_hardware_matrix

Notes: *Systems may require upgraded and/or separately purchased hardware and/or a DVD driv to install the Windows 7 software and take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

Available Processors

Available 1 10cc33	0.0	Clock		Memory			Featuring Intel®	Intel® Turbo	
Name	Cores	Speed (GHz)	Cache (MB)	Speed (MHz)	QPI Speed (GT/s)	Hyper- Threading	VPro™	Boost Technology ¹	TDP (W)
Intel® Xeon® E5-2690 processor	8	2.9	20	1600	8.0	Y	Y	4, 9	135
Intel Xeon E5-2680 processor	8	2.7	20	1600	8.0	Y	Y	4, 8	130
Intel Xeon E5-2670 processor	8	2.6	20	1600	8.0	Y	Y	4, 7	115
Intel Xeon E5-2667 processor	6	2.9	15	1600	8.0	Y	Y	3, 6	130
Intel Xeon E5-2665 processor	8	2.4	20	1600	8.0	Y	Y	4, 7	115
Intel Xeon E5-2660 processor	8	2.2	20	1600	8.0	Y	Y	5, 8	95
Intel Xeon E5-2650 processor	8	2.0	20	1600	8.0	Y	Y	4, 8	95
Intel Xeon E5-2643 processor	4	3.3	10	1600	8.0	Y	Y	1, 2	130
Intel Xeon E5-2640 processor	6	2.5	15	1333	7.2	Y	Y	3, 5	95
Intel Xeon E5-2630 processor	6	2.3	15	1333	7.2	Y	Y	3, 5	95
Intel Xeon E5-2620 processor	6	2.0	15	1333	7.2	Y	Y	3, 5	95
Intel Xeon E5-2609 processor	4	2.4	10	1066	6.4	N	Y	N/A	80
Intel Xeon E5-2603 processor	4	1.8	10	1066	6.4	N	Y	N/A	80



Overview

Intel® Xeon® E5-1660 processor	6	3.3	15	1600	-	Y	Y	3, 6	130
Intel Xeon E5-1650 processor	6	3.2	12	1600	-	Y	Y	3, 6	130
Intel Xeon E5-1620 processor	4	3.6	10	1600	-	Y	Y	2, 3	130
Intel Xeon E5-1607 processor	4	3.0	10	1066	-	N	Y	N/A	130
Intel Xeon E5-1603 processor	4	2.8	10	1066	-	N	Y	N/A	130

¹The specifications shown in this column represent the following: (all core maximum turbo steps, one core maximum turbo steps). Turbo boost stepping occurs in 100MHz increments. Processor that do not have turbo functionality are denoted as N/A.

NOTE: Z620 systems configured with E5-1600 series processors may not add a 2nd processor. I support two processors, E5-2600 series processor must be chosen.

Available Processor Disclaimers

When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details

Multi-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating syste software for full benefits; check with software provider to determine suitability; Not all customers c software applications will necessarily benefit from use of these technologies.

64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processor will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information.

Additional Details

- Intel® Sandy Bridge Architecture
- Intel® C602 Chipset
- Intel® Xeon® processor E5-2600 product family Intel® Xeon® processor E5-1600 product family (Sandy Bridge, Socket R)
- Up to 8.0GT/s QPI support with two QPI links between processors
- 4-channel per processor 1066/1333/1600 MHz DDR3 memory* subsystem
- Up to 96 GB Memory capacity with up to 12 DIMM slots and 8 GB DIMMs
- PCI Express I/O and dual PCle x16 Gen3 graphics support
- Dual Integrated Intel Gigabit LAN on Motherboard (LOM)
- 2 channels of Serial ATA (SATA) 6.0 Gb/s and 8 channels of SATA 3.0 Gb/s natively supported internally
- SATA RAID** 0, 1, 5, and 10 support standard on motherboard
- SAS RAID 0, 1, and 10 supported using the LSI 9212-4i 6Gb/s controller
- SATA optical drives
- High Definition integrated audio with internal speaker
- 800W 90% efficient power supply
- ENERGY STAR® qualification and energy-saving features available on selected configurations (Not supported by Linux)
- Protected by HP Services, including a 3 years parts, 3 years labor, and 3 years onsite service (3/3/3) standard warranty. Terms and conditions vary by country. Certain restriction and exclusions apply.



Overview

Overview	
	*Each processor supports up to 4 channels of DDR3 memory. To realize full performance at least DIMM must be inserted into each channel. To get full 8 channel support, 2 processors MUST be installed. **SATA hardware RAID is not supported on Linux systems. The Linux kernel, with built-in softwar RAID, provides excellent functionality and performance. It is a good alternative to hardware-based
	RAID. Please visit http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf for RAID
	capabilities with Linux.
Form Factor	Rackable Minitower
Color	Brushed aluminum & black
I/O Expansion Slots	Slot 1 (top): PCI Express Gen2 x4(1)* Full-height, Half-length (not available when 2nd CPU/Memory Module is installed) Slot 2: PCI Express Gen3 x16 Full-height, Full-length (with extender)
	Slot 3: PCI Express Gen2 x8(4)* with open-ended connector** Full-height, Full-length (with extender)
	Slot 4: PCI Express Gen3 x8 with open-ended connector** Full-height, Full-length (with extender)
	Slot 5: PCI Express Gen3 x16 Full-height, Full-length (with extender)
	Slot 6: PCI 32bit/33MHz Full-height, Full-length (with extender)
	* x <number> = number of lanes or size of the physical/mechanical connector. (number) = number of lanes supported electrically. Typically communicated as x# mechanical, x(#)electrical. ** open-ended connector allow a greater bandwidth (e.g. x16) card to be installed physically into a significant connector allow a greater bandwidth (e.g. x16) card to be installed physically into a significant connector allow a greater bandwidth (e.g. x16) card to be installed physically into a significant connector.</number>
	lower bandwidth connector/slot.
Mass Storage Bays (see Storage section for more details)	Total bays = 5
Internal Bays	3 internal 3.5" bays (with acoustic dampening rail assemblies pre-installed)
External Bays	2 external 5.25" bays (4th HDD occupies one external bay)
Front I/O	2 USB 3.0, 1 USB 2.0, 1 Headphone, 1 Microphone, 1 IEEE 1394a
Rear I/O	2 USB 3.0, 4 USB 2.0, 2 RJ-45 integrated Gigabit LAN, 2 PS/2, 1 Audio Line-In, 1 Audio Line-Ou 1 Microphone Serial supported with optional connector on PCI bracket cabled to system board connector
Internal USB	6 USB 2.0
	44.45 x 17.15 x 46.48 cm (17.5 x 6.75 x 18.3 in)
System Weight	Actual weight depends upon configuration Minimum config: 15.5 kg (34.2 lb) Typical config: 17.9 kg (39.4 lb) Maximum config: 22.6 kg (49.9 lb)



Overview

Temperature	Operating:	5° to 35° C (40° to 95° F)
	Non-operating	-40° to 60° C (-40° to 140° F)
Humidity	Operating:	8% to 85% relative humidity, non-condensing
	Non-operating	8% to 90% relative humidity, non-condensing
Maximum Altitude	Operating:	3,048m (10,000ft)
(non-pressurized)	Non-operating	9,144m (30,000ft)
Power Supply	Tool-free 800W 90% Efficier	nt wide-ranging, active Power Factor Correction
	The Power Supply Efficienc	y Report for this product may be found at this link: TBD
Interfaces Supported		(2 @ 6.0 Gb/s and 8 @ 3.0 Gb/s). 6 channels are eSATA configurable
1	, ,	or use with eSATA CTO/AMO Kit.
1	SAS interface supported	
	USB 3.0, USB 2.0, IEEE 13	94a interface
Hard Drive Controllers	SATA and SAS controllers	
Supported		
Backup Devices	For a complete listing of con	npatible DAT tape drives, LTO tape drives and RDX Removable Disk
	Backup System offerings, p	lease visit http://www.hp.com/go/connect
Workstation ISV	See the latest list of certification	ations at
Certifications	http://www.hp.com/united-s	tates/campaigns/workstations/partnerships.html



Supported Components

Processors

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Intel Xeon E5-2600 Series - CTO				
Intel® Xeon® Processor E5-2603 4C 1.80GHz	Υ	N		
Intel® Xeon® Processor E5-2609 4C 2.40GHz	Υ	N		
Intel® Xeon® Processor E5-2620 6C 2.00GHz	Υ	N		
Intel® Xeon® Processor E5-2630 6C 2.30GHz	Υ	N		
Intel® Xeon® Processor E5-2640 6C 2.50GHz	Υ	Ν		
Intel® Xeon® Processor E5-2643 4C 3.30GHz	Υ	Ν		
Intel® Xeon® Processor E5-2650 8C 2.00GHz	Υ	Ν		
Intel® Xeon® Processor E5-2660 8C 2.20GHz	Υ	N		
Intel® Xeon® Processor E5-2665 8C 2.40GHz	Υ	N		
Intel® Xeon® Processor E5-2667 6C 2.90GHz	Υ	N		
Intel® Xeon® Processor E5-2670 8C 2.60GHz	Υ	Ν		
Intel® Xeon® Processor E5-2680 8C 2.70GHz	Υ	Ν		
Intel® Xeon® Processor E5-2690 8C 2.90GHz	Υ	Ν		
Intel Xeon E5-1600 Series				
Intel® Xeon® Processor E5-1660 6C 3.30GHz	Υ	Ν		
Intel® Xeon® Processor E5-1650 6C 3.20GHz	Υ	Ν		
Intel® Xeon® Processor E5-1620 4C 3.60GHz	Υ	Ν		
Intel® Xeon® Processor E5-1607 4C 3.00GHz	Υ	Ν		
Intel® Xeon® Processor E5-1603 4C 2.80GHz	Υ	Ν		
Intel Xeon E5-2600 Series - Z620 AMO				
Z620 Xeon E5-2603 4C 1.80 10MB 1066 CPU2	N	Υ	A6S72AA	
Z620 Xeon E5-2609 4C 2.40 10MB 1066 CPU2	N	Υ	A6S73AA	
Z620 Xeon E5-2620 6C 2.00 15MB 1333 CPU2	N	Υ	A6S74AA	
Z620 Xeon E5-2630 6C 2.30 15MB 1333 CPU2	N	Υ	A6S75AA	
Z620 Xeon E5-2640 6C 2.50 15MB 1333 CPU2	N	Υ	A6S76AA	
Z620 Xeon E5-2643 4C 3.30 10MB 1600 CPU2	N	Υ	A6S77AA	
Z620 Xeon E5-2650 8C 2.00 20MB 1600 CPU2	N	Υ	A6S78AA	
Z620 Xeon E5-2660 8C 2.20 20MB 1600 CPU2	N	Υ	A6S79AA	
Z620 Xeon E5-2665 8C 2.40 20MB 1600 CPU2	N	Υ	A6S80AA	
Z620 Xeon E5-2667 6C 2.90 15MB 1600 CPU2	N	Υ	A6S81AA	
Z620 Xeon E5-2670 8C 2.60 20MB 1600 CPU2	N	Υ	A6S82AA	
Z620 Xeon E5-2680 8C 2.70 20MB 1600 CPU2	N	Υ	A6S83AA	
Z620 Xeon E5-2690 8C 2.90 20MB 1600 CPU2	N	Υ	A6S84AA	
NOTE 4: When ordering two processors the second	d			

NOTE 1: When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details.

Multi-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.

64-bit computing on Intel® 64 architecture requires a computer system with a processor,





Supported Components

chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processor will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information.

Intel's numbering is not a measurement of higher performance. Z620 processor AMO kits include:

- 2nd CPU/Memory Module (riser)
- processor
- heat sink

SAS Hard Drives		Factory Configured	Option Kit	Option Kit Part Support Number Notes			
	HP SAS (Serial Attached SCSI) Hard Drives for	HP Workstat	ions				
	HP 300GB SAS 10K SFF HDD	Y	Υ	A2Z20AA			
	HP 600GB SAS 10K SFF HDD	Y	Υ	A2Z21AA			
	300GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	LU967AA			
	450GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	LU968AA			
	600GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	VM647AA			
	Sub-Section Description/Notes						
	NOTE: SAS Controller add-in card required						
SATA Hard Drives	SATA (Serial ATA) Hard Drives for HP Worksta	tions					
	250GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ034AA			
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ036AA			
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ037AA			
	2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QB576AA			
	3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QF298AA			
SATA Solid State	HP Solid State Drives (SSDs) for Workstations						
Drives	HP 128GB SATA SSD	Υ	Υ	A3D25AA			
	HP 256GB SATA SSD	Υ	Υ	A3D26AA			
	HP 160GB SATA SSD	Υ	Υ	LZ704AA			
	HP 300GB SATA SSD	Υ	Υ	LZ069AA			
	For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes. Actual formatted capacity is less. Up to 12 GB of hard drive (or system disk) is reserved for the system recovery software (XP and XP Pro). Up to 3 GB of system disk is reserved for system recovery software (Vista). Up to 4 drives are allowed. The 4th drive will occupy one of the external 5.25" bays.						



Supported Components

Hard Drive Controllers

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Integrated SATA 6.0 Gb/s Controller				
Integrated SATA 6.0 Gb/s Controller	Υ	N		Two ports
Integrated SATA 3.0 Gb/s Controller				
Integrated SATA 3.0 Gb/s Controller	Υ	N		Eight ports
Factory integrated RAID on motherboard	for SATA drive	es		
RAID 0 Configuration - Striped Array	Υ	N		See note 1
RAID 1 Configuration - Mirrored Array	Υ	N		See note 1
RAID 10 Configuration - Striped/Mirrored Array	Y	N		See note 1
RAID 0 Data Configuration Boot/OS Drive + 2 Drive Striped Array	Y	N		See note 1
LSI 9212 4-Port SAS 6Gb/s RAID Card				
LSI 9212 4-Port SAS 6Gb/s RAID Card	Υ	Υ	XP310AA	
LSI MegaRAID® 9260-8i SAS 6Gb/s ROC R	AID Card and	iBBU08 E	Battery Backup	Unit
LSI MegaRAID® 9260-8i SAS 6Gb/s ROC RAID Card	N	Υ	WE465AA	
Optional: LSI iBBU08 Battery Backup Unit for LSI 9260-8i	N	Υ	LA783AA	

NOTE 1: Requires 2 identical hard drives (speeds, capacity, interface). RAID 1 does not support a 3rd HDD. No Linux support for SATA RAID.

NOTE: Specific user-configured hardware SAS RAID configurations are supported on this system with Linux. Please visit: http://www.hp.com/support/linux_hardware_matrix for details.

LSI RAID Definitions:

SATA hardware RAID is not supported on Linux systems. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit

http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf for RAID capabilities with Linux.

IS: Striping of 2 or more HDDs into a single logical volume

IM: Mirroring of 2 HDDs into a single logical volume

All RAID arrays must be less than 2 TB in size

IME: Mirroring of 3 or more HDDs into a single logical volume

NOTE: Specific user-configured hardware SAS RAID configurations are supported on this Linux system. Please visit: http://www.hp.com/support/linux_hardware_matrix for details



Supported Components

Graphics				Option		Support
Graphics		Factory Configured	Option Kit	Kit Part Number	Support Notes	Support Multi Mixed
	Professional 2D					
	AMD FirePro 2270 512MB Graphics Card	Υ	Υ	LA524AA		4
	NVIDIA NVS300 512MB PCIe Graphics Card	Υ	Υ	XP612AA		4
	NVIDIA NVS 310 512MB Graphics Card	Υ	Υ	A7U59AA		3
	NVIDIA Quadro NVS 450 512 MB PCIe Graphics Card	Υ	Y	FH519AA	2nd card must be NVS 450 or NVS 310	
	Entry 3D					
	NVIDIA Quadro 410 512MB Graphics	Υ	Υ	A7U60AA		2
	NVIDIA Quadro 600 1GB Graphics Card	Y	Υ	WS093AA		2
	AMD FirePro V3900 1GB Graphics Card	Υ	Υ	A6R69AA		2
	AMD FirePro V4900 1GB Graphics Card	Υ	Υ	A3J92AA		2
	Mid-range 3D					
	NVIDIA Quadro 2000 1GB Graphics Card	Υ	Υ	WS094AA		2
	AMD FirePro V5900 2GB Graphics	Υ	Υ	LS992AA		2
	High End 3D					
	AMD FirePro V7900 2GB Graphics	Υ	Υ	LS993AA		2
	NVIDIA Quadro 4000 2GB Graphics Card	Υ	Υ	WS095AA		2
	NVIDIA Quadro 5000 2.5GB Graphics Card	Υ	Υ	WS096AA		2
	NVIDIA Quadro 6000 6GB Graphics Card	Υ	Υ	WS097AA		2
High Performance					Option	
GPU Computing		(Factory Configure	•	Kit Part Number	Support Notes
	NVIDIA Tesla C2075 Compute Proces	sor	Υ	Υ	QB035AA	See note 1
	NOTE 1: Tesla C2075 does not have a combination with NVIDIA Quadro 410			output and	is only suppo	rted in

Supported Components

Memory CTO Option Kit Part Support Notes
Number

DDR3-1600 ECC Unbuffered DIMMs - CTO

2GB DDR3-1600 ECC Unbuffered RAM 4GB DDR3-1600 ECC Unbuffered RAM **DDR3-1600 ECC Registered DIMMs - CTO** 4GB DDR3-1600 ECC Registered RAM 8GB DDR3-1600 ECC Registered RAM

Sub-Section Description/Notes

HP DX115 Removable HDD Carrier

The Z620 has a four-channel memory architecture. Four channels are associated with each processor. For optimal performance, populate a DIMM in each channel.

AMO

DDR3-1600 ECC Registered DIMMs - AMO

4GB DDR3-1600 ECC Registered RAM A2Z49AA 8GB DDR3-1600 ECC Registered RAM A2Z51AA

DDR3-1600 ECC Unbuffered DIMMs - AMO

HP 2GB (1x2GB) DDR3-1600 ECC RAM A2Z47AA HP 4GB (1x4GB) DDR3-1600 ECC RAM A2Z48AA

NOTE: Although all of these memory selections incorporate 1600MHz memory modules, the speed at which they operate is dependent upon the processor.

Multimedia and Audio Devices		Factory Configured	•	Option Kit Part Number	
	Integrated Intel/Realtek HD ALC262 Audio	Υ	Ν		
	HP Thin USB Powered Speakers	Υ	Υ	KK912AA	

Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP 16X DVD-ROM SATA Drive (non- Lightscribe version)	Υ	Υ	AR629AA	See note 1
	HP 16X DVD+/-RW SuperMulti SATA Drive (non-Lightscribe)	Υ	Υ	QS208AA	
	HP Slot Load DVD+/-RW Drive	Υ	Ν		
	HP Blu-ray Writer	Υ	Υ	AR482AA	See note 2
	HP 22-in-1 Media Card Reader Kit (Workstations)	Υ	Y	NK361AA	
	HP DX115 Removable Drive Enclosure				
	HP DX115 Carrier with 160GB SATA HDD	N	Υ	FZ577AA	
	HP DX115 Removable HDD Frame/Carrier	N	Υ	FZ576AA	

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

Ν

NB792AA

As Blu-ray is a new format containing new technologies, certain disc, digital connection,





Supported Components

compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

NOTE 1: Not supported as a 2nd Optical Drive.

NOTE 2: Cannot be ordered in combination with another Blu-ray Writer.

Controller Cards		Factory Configured	•	Option Kit Part Number	• •
	HP IEEE 1394b FireWire PCIe Card	Υ	Υ	NK653AA	

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated Intel 82579LM PCIe GbE Controller	Υ	N		See note 2
	Broadcom NetXtreme Gigabit Ethernet Plus NIC (PCIe)	Y	Υ	FS215AA	See notes 1 and 2
	Intel Gigabit CT Desktop NIC	N	Υ	FH969AA	See note 2
	HP NC360T PCI Express Dual Port Gigabit NIC	N	Y	KU004AA	See note 2

NOTE 1: This is a PCI Express card based on the Broadcom 5761 chip. This card does not support DASH 1.1 manageability on this platform.

NOTE 2: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Racking and Physical Security		Factory Configured	•	Option Kit Part Support Number Notes
	Security Cable with Kensington Lock	N	Υ	PC766A
	HP (CMT) Solenoid Lock	N	Υ	DE618A
	HP Solenoid Hood Lock & Hood Sensor	Υ	N	
	HP Z6/Z8 Adjustable Sliding Rail Rack Kit	N	Υ	NN124AA



Supported Components

Input Devices		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP PS/2 Standard Keyboard	Υ	Υ	DT527A	
	HP USB Standard Keyboard	Υ	Υ	DT528A	
	HP PS/2 Optical Scroll Mouse	Υ	Υ	EY703AA	
	HP USB 2-Button Optical Scroll Mouse	Υ	Υ	DC172B	
	HP USB Laser Mouse	Υ	Υ	GW405AA	
	HP USB Optical 3-Button Mouse	Υ	Υ	DY651A	
	HP USB Smart Card Keyboard	Υ	Υ	ED707AA	
	HP 2.4GHz Wireless Keyboard & Mouse	N	Υ	NB896AA	
	HP USB Optical 3-Button 2.9M OEM Mouse	N	Υ	ET424AA	
	HP SpaceExplorer 3D USB Controller	N	Υ	RY429AA	
	HP SpacePilot 3D USB Intelligent Controller	N	Υ	EF390AA	

Other Hardware				Option	
		Factory Configured	Option Kit	Kit Part Number	Support Notes
	HP Workstation Mouse Pad	Υ	N		Japan only.
	HP Power Cord Kit	N	Υ	DM293A	
	HP eSATA PCI Cable Kit	N	Υ	GM110AA	
	HP Serial Port Adapter	N	Υ	PA716A	
	HP Internal USB Port Kit	N	Υ	EM165AA	
	HP Optical Bay HDD Mounting Bracket	Y	Y	NQ099AA	For 3.5" HDDs
	HP Energy Star Enabled Configuration	Υ	N		

Software		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Performance Advisor	Υ	Υ		See note 1
	HP Remote Graphics Software (RGS) V5	Υ	N		See note 2
	HP ProtectTools Security	Υ	N		See note 3
	MS Office Home & Business 2010	Υ	N		See note 4
	HP Power Assistant	Υ	N		
	Roxio Easy Media Creator (DVD/Blu-ray Disc burner software)	Υ	N		
	Intervideo WinDVD (DVD player/burner software)	Υ	N		
	PDF Complete - Trial Edition	Υ	N		
	NOTE 1: Available as a free download here: www.	hn com/go/ner	formance	advisor	

NOTE 1: Available as a free download here: www.hp.com/go/performanceadvisor

NOTE 2: Supports both 32 and 64 bit versions of Windows 7 Professional and Enterprise,

Windows XP Professional and Enterprise, and RHEL V6

NOTE 3: Must select as a Configure to Order option. Delivered as a "Drop in the Box" CD

NOTE 4: Must select as a Configure to Order option



Supported Components

Operating Systems Support Notes

Genuine Windows® 7 Ultimate See Note 1

64-bit

Genuine Windows® 7 See Note 1

Professional 64-bit

Genuine Windows® 7 See Note 1

Professional 32-bit HP Linux Installer Kit

Red Hat Enterprise Linux (RHEL) See Note 2

Workstation - Paper License (1yr)

NOTE 1: See http://www.microsoft.com/windows/windows-7/ for support details.

NOTE 2: This second OS must be ordered with the HP Linux Intaller Kit as the first OS.



System Board	
System Board Form Factor	Main System Board: 24 x 31 cm 9.6 x 12.2 inches 2nd CPU/Memory Board (optional): 14.9 x 29.2 cm 5.85 x 11.50 inches
Processor Socket	LGA2011 1st CPU on system board 2nd CPU on optional 2nd CPU/Memory Module
CPU Bus Speed	QPI: Up to 8.0GT/second, depending on processor
Chipset	Intel C602 Chipset
Super I/O Controller	Nuvoton NPCD379H (SIO-12)
Memory Expansion Slots	8 on system board(CPU0) + 4 on optional 2nd CPU/Memory Module (CPU1)
Memory Type Supported	DDR3, UDIMM (Unbuffered), ECC: 2GB and 4GB DDR3, RDIMM (Registered), ECC: 4GB and 8GB
Memory Modes	NUMA (Non-Uniform Memory Architecture), Memory Node Interleave
Memory Speed Supported	1066, 1333, & 1600MHz



		Single Processor								
		CPU0 Front Slots				CPU0 Rear Slots				
Capacity (GB)	Туре	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6	DIMM 7	DIMM 8	
2	UDIMM	2GB					8 8			
4	UDIMM	2GB							2GB	
6	UDIMM	2GB		2GB					2GB	
8	UDIMM	2GB		2GB			2GB		2GB	
12	UDIMM	2GB	2GB	2GB			2GB	2GB	2GB	
16	UDIMM	2GB	2GB	2GB	2GB	2GB	2GB	2GB	2GB	
16	UDIMM	4GB		4GB			4GB		4GB	
16	RDIMM	4GB		4GB			4GB		4GB	
24	UDIMM	4GB	2GB	4GB	2GB	2GB	4GB	2GB	4GB	
32	UDIMM	4GB	4GB	4GB	4GB	4GB	4GB	4GB	4GB	
32	RDIMM	4GB	4GB	4GB	4GB	4GB	4GB	4GB	4GB	
32	RDIMM	8GB		8GB			8GB		8GB	
48	RDIMM	8GB	4GB	8GB	4GB	4GB	8GB	4GB	8GB	
64	RDIMM	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	
Slot Loa	d Order	1	5	3	7	8	4	6	2	



System Technical Specifications

		Dual Processor											
	- 20			U0 Slots		CPUO Rear Slots			CPU1 Front Slots		CPU1 Rear Slots		
Capacity (GB) Type	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6	DIMM 7	DIMM 8	DIMM 1	DIMM 2	DIMM 3	DIMM 4	
4	UDIMM	2GB						-		2GB			
8	UDIMM	2GB							2GB	2GB			2GB
12	UDIMM	2GB		2GB					2GB	2GB	2GB		2GB
16	UDIMM	2GB		2GB			2GB		2GB	2GB	2GB	2GB	2GB
20	UDIMM	2GB	2GB	2GB			2GB	2GB	2GB	2GB	2GB	2GB	2GB
24	UDIMM	2GB	2GB	2GB	2GB	2GB	2GB	2GB	2GB	2GB	2GB	2GB	2GB
32	UDIMM	4GB		4GB			4GB		4GB	4GB	4GB	4GB	4GB
32	RDIMM	4GB		4GB			4GB		4GB	4GB	4GB	4GB	4GB
48	UDIMM	4GB	4GB	4GB	4GB	4GB	4GB	4GB	4GB	4GB	4GB	4GB	4GB
48	RDIMM	8G8		4GB			4GB		8GB	8GB	4GB	4GB	8GB
64	RDIMM	8GB		8GB			8G8		8GB	8GB	8GB	8GB	8GB
80	RDIMM	8GB	4GB	8GB	4GB	4GB	8GB	4GB	8GB	8GB	8GB	8GB	8GB
96	RDIMM	8GB	8G8	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB
Slot Loa	d Order	1	9	5	11	12	7	10	3	2	6	8	4

NOTE: CPU0 is located on the main system board. CPU1 (optional) is located on an add-in riser card.

Maximum Memory	Supports up to 96GB
Memory Configuration (Supported)	 Not all memory configurations possible are represented above. Only ECC DIMMs are supported. Do not install memory modules into memory slots if corresponding processor is installed. Dual processor configurations with memory modules installed for only one processor is not supported. UDIMM (Unbuffered) and RDIMM (Registered) memory cannot be mixed. All memory installed in the system must be either UDIMM or RDIMM.
PCI Express Connectors	Slot 1 (top): PCI Express Gen2 x4(1)* Full-height, Half-length (not available when 2nd CPU/Memory Module is installed) Slot 2: PCI Express Gen3 x16 Full-height, Full-length (with extender) Slot 3: PCI Express Gen2 x8(4)* with open-ended connector** Full-height, Full-length (with extender) Slot 4: PCI Express Gen3 x8 with open-ended connector** Full-height, Full-length (with extender) Slot 5:



System	Technical	Specifications

System Lechnical Specific	cations				
	PCI Express Gen3 x16 Full-height, Full-length (with extended)	er)			
	(number) = number of lanes support mechanical, x(#)electrical.	size of the physical/mechanical connector. rted electrically. Typically communicated as x# eater bandwidth (e.g. x16) card to be installed connector/slot.			
PCI Connectors (5.0V)	Slot 6: PCI 32bit/33MHz Full-height, Full-length (with extender)				
Supported Drive Interfaces	SATA	Integrated 10-channel SATA interface (2@6Gb/s 8@3Gb/s). Supports RAID 0, 1, 5, 10 and NCQ. Factory integrated RAID is Microsoft Windows of			
	Serial Attached SCSI	Requires Optional PCIe card			
Integrated RAID	 Integrated SATA RAID RAID 0, RAID 1*, RAID 5, RAID 10 Supports one RAID array with 2-4 drives RAID 0 configuration - striped array (supported and configure to order) RAID 1 configuration - mirrored array (supported and configure to order) RAID 5 parity striping (supported but not configure to order) RAID 10 striped and mirrored array (supported but not configure to order) *HW RAID functionality not supported by Linux. Use SW RAID functionality provided				
Integrated Graphics	the Red Hat Operating system inste				
Network Controller	 Integrated Intel 82579 and 82574 Controllers. Memory Integrated 48KB receive buffer and 8KB transmit buffer Data rates supported 10/100/1000 Mb/s Compliance IEEE 802.3, 802.3AB and 802.3u compliant, 802.3x flow control Bus architecture PCIe 1.0a Data path width X1 Data path speed 2.5Gbit per sec per direction transfer rate Data transfer mode Bus-master DMA Power requirement 1.0 watts @ +3.3V AUX supply Boot ROM support Yes Network transfer rate 10BASE-T (half-duplex) 10 Mb/s 10BASE-TX (half-duplex) 20 Mb/s 100BASE-TX (full-duplex) 200 Mb/s 1000BASE-TX (full-duplex) 200 Mb/s Microsoft Windows Vista Business 32 and 64, Microsoft Windows XP Profess 32 and 64 Management capabilities AMT/vPro Technology 				
SATA Connectors	10 ports/connectors (6 ports may be cabled to optional eSATA cable kits [2 ports per cable kit])				
IEEE 1394a or 1394b	1394a is integrated 1394b is optional with PCIe card Cable from Front IO can be plugged into PCIe Card. Not supported in Linux				
IEEE 1394 Connector(s)	Front	1 - 1394a			
	Rear	1 - 1394a			
	Internal	No			
USB Connector(s)	Front	1 - USB 2.0 2 - USB 3.0			



	Rear		4 - USB 2.0 2 - USB 3.0	
	Internal		6 - USB 2.0 (3x 2	2x5 headers)
				tion for optional HP Internal USI dia Card Reader
HD Integrated Audio	Realtek ALC262	2		
Flash ROM	Yes			
CPU Fan Header	One for each C	PU socket		
Chassis Fan Header		hassis Fan Header hassis Fan Header		
CMOS Battery Holder – Lithium	Yes			
Integrated Trusted Platform Module	TPM 1.2, Infined	on		
Power Supply Headers	Yes			
Power Switch, Power LED & Hard Drive LED Header	Yes (includes s	peaker and intrusion	sensor signals)	
Clear Password Jumper	Yes			
Serial Port	Optional			
Parallel Port	No			
Keyboard/Mouse	PS/2			
Z620 Required Power Supply In	fo			
Power Supply		800W 90% Efficient, Custom PSU (Wide Ranging, Active PFC)		
Operating Voltage Range		90–269 VAC		
Rated Voltage Range		100–24	0 V	118 V
Rated Line Frequency		50–60		400 Hz
Operating Line Frequency Rang	je	47–66		393–407 Hz
Rated Input Current		9.7 A @ 100		9.7 A @ 400 V
Heat Dissipation (Configuration and software dep	pendent)	Typical = 1972 btu/hr (497kg-cal/hr) Maximum = 3139 btu/hr (791 kg-cal/hr)		
Power Supply Fan			92x25 mm vari	•
ENERGY STAR Qualified (Configuration dependent)			Yes	3
80 PLUS® Compliant		Yes, 90% Efficient		
		The Z620 800W power supply efficiency report can be found at this TBD		
FEMP Standby Power Complian on LAN disabled)(<2W in S5-Pov	•		Yes	:
EuP Compliant@230V (<1 W in S	S5-Power Off)		Yes	3
CECP Compliant @ 220V (<4W in S3 - Suspend to RAM)		Yes; Configuration	on dependent	
Power Consumption in sleep me by ENERGY STAR) - Suspend to (Instantly Available PC) measure	RAM (S3)		<15V	V
Built-in Selft Test LED			Yes	3
Surge Tolerant Full Ranging Po (withstands power surges up to			Yes	3



System Technical Specifications

Access Panel Solenoid Lock Header	Yes
Access Panel Intrusion Sensor Header	Yes Integrated in Front User Interface (Power Switch, Power LED, HDD LED, Speaker) Cable
Multibay Header	No
Integrated Gigabit Ethernet	Integrated Intel 82579 and 82574 Controllers
Wake on LAN	Yes
ASF 1.0/2.0 (Alert Standard Format)	No
ТРМ	Integrated TPM 1.2; Infineon
Password Clear Header	Yes
AUX IN (audio)	No
Clear CMOS Button	Yes
Memory Fan Header	CPU0 Memory Fan Header; CPU1 Memory Fan Header

System Configuration

Example Configuration	Processor Info	1x Intel Xeo	n E5-2650 (E	Eight-Core)			
#1	Memory Info	4x 2GB DDR3 1600 (UDIMM)					
(ENERGY STAR	Graphics Info	1x NVIDIA Quadro 600					
QUALIFIED)	Disks/Optical/Floppy	1x 250GB S	ATA 7200/1	x 16X DVD-I	ROM SATA		
	Power Supply	800W 90%	Custom PSI	J			
	Other	1x NVIDIA T	esla C2075				
Energy Consumption			VAC		VAC		VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disab
	Windows Idle (S0)	111	1 W	110) W	111	1 W
	Windows Busy Typ (S0)	287	7 W	276	6 W	286	6 W
	Windows Busy Max (S0)	396	6 W	390) W	398	3 W
	Sleep (S3)	4.25 W	4.10 W	4.43 W	4.31 W	4.25 W	4.11 W
	Off (S5)	1.81 W	1.62 W	2.07 W	1.89 W	1.79 W	1.61 W
	Zero Power Mode (ErP)	0.2	5 W	0.4	5 W	0.23	3 W
Heat Dissipation**		115	VAC	230 VAC		100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disab
	Windows Idle (S0)	379 b	otu/hr	375 b	otu/hr	379 b	otu/hr
	Windows Busy Typ (S0)	979 b	otu/hr	942 b	otu/hr	976 b	otu/hr
	Windows Busy Max (S0)	1351	btu/hr	1331	btu/hr	1358	btu/hr
	Sleep (S3)	14.5 btu/hr	14.0 btu/hr	15.1 btu/hr	14.7 btu/hr	14.5 btu/hr	14.0 btu/
	Off (S5)	6.18 btu/hr	5.53 btu/hr	7.06 btu/hr	6.45 btu/hr	6.11 btu/hr	5.49 btu/
	Zero Power Mode (ErP)	0.85	btu/hr	1.54	btu/hr	0.78	btu/hr



Example Configuration		1x Intel Xeon E5-2643 (Four-Core)					
#2		4x 4GB DDR3 1600 (UDIMM)					
(ENERGY STAR	Graphics Info	1x NVIDIA N					
QUALIFIED)		2x 500GB S			ROM SATA		
	Power Supply	800W 90%	Custom PSI	J			
	Other	-					
Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disab
	Windows Idle (S0)	66.8	8 W	66.3	3 W	66.	9 W
	Windows Busy Typ (S0)	170) W	169) W	17°	1 W
	Windows Busy Max (S0)	193	3 W	190 W		193 W	
	Sleep (S3)	4.43 W	4.31 W	4.62 W	4.51 W	4.43 W	4.33 W
	Off (S5)	1.81 W	1.38 W	2.07 W	1.64 W	1.78 W	1.36 W
	Zero Power Mode (ErP)	0.24	4 W	0.4	5 W	0.2	3 W
Heat Dissipation**		115	VAC	230 VAC		100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disab
	Windows Idle (S0)	228 b	otu/hr	226 b	tu/hr	228 k	otu/hr
	Windows Busy Typ (S0)	580 b	otu/hr	577 b	tu/hr	583 k	otu/hr
	Windows Busy Max (S0)	659 b	otu/hr	648 b	tu/hr	659 k	otu/hr
	Sleep (S3)	15.1 btu/hr	14.7 btu/hr	15.8 btu/hr	15.4 btu/hr	15.1 btu/hr	14.8 btu/
	Off (S5)	6.18 btu/hr	4.71 btu/hr	7.06 btu/hr	5.60 btu/hr	6.07 btu/hr	4.64 btu/
	Zero Power Mode (ErP)	0.82	btu/hr	1.54	otu/hr	0.78	btu/hr

Example Configuration	Processor Info	2x Intel Xeo	n E5-2690 (E	Eight-Core)			
#3	Memory Info		R3 1600 (RĎ				
(ENERGY STAR	Graphics Info	1x NVIDIA Quadro 2000					
QUALIFIED)	Disks/Optical/Floppy	2x 250GB S	SATA 7200/1	x 16X DVD+	-RW Superl	Multi SATA	
	Power Supply	800W 90%	Custom PSI	J			
	Other						
Energy Consumption			VAC		VAC		VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disab
	Windows Idle (S0)	121	1 W	120) W	12:	2 W
	Windows Busy Typ (S0)	506	6 W	494	1 W	518	3 W
	Windows Busy Max (S0)	541	1 W	53 ²	I W	544	1 W
	Sleep (S3)	7.75 W	7.57 W	7.84 W	7.67 W	7.82 W	7.62 W
	Off (S5)	1.97 W	1.57 W	2.18 W	1.82 W	1.96 W	1.55 W
	Zero Power Mode (ErP)	0.2	4 W	0.4	4 W	0.2	3 W
Heat Dissipation**		115 VAC 230 VAC 100 V		VAC			
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disab
	Windows Idle (S0)	413 b	otu/hr	409 k	otu/hr	416 l	otu/hr
	Windows Busy Typ (S0)	1727	btu/hr	1686	btu/hr	1767	btu/hr
	Windows Busy Max (S0)	1846	btu/hr	1812	btu/hr	1856	btu/hr
	Sleep (S3)	26.4 btu/hr	25.8 btu/hr	26.8 btu/hr	26.2 btu/hr	26.7 btu/hr	26.0 btu/
	Off (S5)	6.72 btu/hr	5.36 btu/hr	7.44 btu/hr	6.21 btu/hr	6.69 btu/hr	5.29 btu/
	Zero Power Mode (ErP)	0.82	btu/hr	1.50	btu/hr	0.78	btu/hr

Example Configuration	Processor Info	2x Intel Xeon E5-2620 (Six-Core)					
#4	Memory Info	12x 4GB DE	R3 1600 (Ú	DIMM)			
	Graphics Info	2x NVIDIA Quadro 5000					
	Disks/Optical/Floppy	4x 600GB S	AS 15K/1x	16X DVD+-F	RW SuperMu	ılti SATA	
		800W 90%		J			
	Other	LSI 9212 SA	AS Card				
Energy Consumption			VAC		VAC		VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disab
	Windows Idle (S0)	216	6 W	213	3 W	217	7 W
	Windows Busy Typ (S0)	525	5 W	485	5 W	512	2 W
	Windows Busy Max (S0)	644	1 W	63 ²	1 W	647	7 W
	Sleep (S3)	9.27 W	8.81 W	9.36 W	8.91 W	9.31 W	8.89 W
	Off (S5)	1.85 W	1.43 W	2.12 W	1.68 W	1.83 W	1.41 W
	Zero Power Mode (ErP)	0.2	5 W	0.4	5 W	0.23	3 W
Heat Dissipation**		115	VAC	230	VAC	100	VAC
- 		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disab
	Windows Idle (S0)	737 b	otu/hr	727 b	otu/hr	740 b	otu/hr
	Windows Busy Typ (S0)	1791	btu/hr	1655	btu/hr	1747	btu/hr
	Windows Busy Max (S0)	2197	btu/hr	2153	btu/hr	2208	btu/hr
	Sleep (S3)	31.6 btu/hr	30.1 btu/hr	31.9 btu/hr	30.4 btu/hr	31.8 btu/hr	30.3 btu/
	Off (S5)	6.31 btu/hr	4.88 btu/hr	7.23 btu/hr	5.73 btu/hr	6.24 btu/hr	4.81 btu/
	Zero Power Mode (ErP)	0.85	btu/hr	1.54	btu/hr	0.78	btu/hr

Declared Noise Emissions (Entry-level and High-end configurations)			
System Configuration Processor Info Single Intel Xeon E5-2640 2.50 GHz			
(Entry level)	Memory Info	4 - 2 GB DDR3 1333 MHz UDIMM	
	Graphics Info	NVIDIA Q400	
	Disks/Optical/Floppy	Single 1 TB 7200 RPM SATA	

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.3	16
	Hard drive Operating (random reads)	3.9	22
	DVD-ROM Operating (sequential reads)	5.1	39

System Configuration	Processor Info	Dual Xeon E5-2690 2.90 GHz
(High-end)	Memory Info	12 - 4GB DDR3 1600 MHz UDIMM
	Graphics Info	NVIDIA Q4000
	Disks/Optical/Floppy	Dual 600 GB 15K RPM SAS 3.5"
		DVD ROM



Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	4.4	29
	Hard drive Operating (random reads)	4.8	32
	DVD-ROM Operating (sequential reads)	5.1	36

Environmental Requirements	Temperature	Operating: 5°C to 35°C (40°F to 95°F) Non-operating: -40°C to 60°C (-40°F to 140°F)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 3,048 m (10,000 ft) Non-operating: 9,144 m (30,000 ft)
	Dynamic (new)	Shock Operating: ½-sine: 40g, 2-3ms Non-operating: ½-sine: 160 cm/s, 2-3ms (~100g) square: 422 cm/s, 20g NOTE: Values represent individual shock events and do not indicate repetitive shock events. Vibration Operating random: 0.5g (rms), 5-300 Hz Non-operating random: 2.0g (rms), 10-500 Hz NOTE: Values do not indicate continuous vibration.
	Cooling	Above 1524m (5,000 ft) altitude, maximum operating temperature is de rated by 1°C (1.8°F) per 305m (1,000 ft) elevation increase

Physical Securit	ty and Serviceability
Access Panel	Tool-less Includes system board and memory information
Optical Drive	Tool-less, no carrier or rails required
Hard Drives	Tool-less Integrated blind-mate drive carriers
	Optional 5.25" external bay carriers
Expansion Cards	Tool-less
Processor Socket	1st socket on main system board. 2nd socket on optional 2nd CPU/Memory Module.
Green User Touch Points	Yes, on primary serviceable components
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Tool-less 2nd CPU/Memory Module: Tool-less
Dual Color Power and HD LED on Front of Computer	Yes



Cyclem recommodic	Specifications
Configuration Record SW	Yes
Over-Temp Warning on Screen	Yes, at POST screen on reboot.
Restore CD/DVD Set	Yes, restores the computer to its original factory shipping image - Can be obtained via HP Support.
Dual Function Front Power Switch	Yes, also acts as a reset switch when held for 4 seconds.
Padlock Support	No
Cable Lock Support	Yes, Kensington Cable Lock (optional): Prevents entire system theft only. 3mm x 7mm slot a rear of system
Universal Chassis Clamp Lock Support	No
Solenoid Lock and Hood Sensor	Access Panel Solenoid Lock: Yes (optional). Activated remotely to prevent system entry. Access Panel Intrusion Sensor: Yes (optional).
Rear Port Control Cover	No
Removable Media Write/Boot Control	Yes, user can prevent the workstation from writing to or booting from removable media.
Power-On Password	Yes, prevents an unauthorized person from booting up the computer.
Setup Password	Yes, prevents an unauthorized person from changing the system configuration.
3.3V Aux Power LED	No
on System PCA	
NIC LEDs (integrated) (Green & Amber)	Yes
CPUs and Heatsinks	CPU heatsink removal requires a T-15 Torx or flat blade screwdriver. CPU removal is toolless.
Power Supply Diagnostic LED	Yes
Front Power Button	Yes
Rear Power Button	Yes
Front Power LED	Yes, blue (normal), red (fault)
Front Hard Drive Activity LED	Yes, green
Front ODD Activity LED	Yes
Internal Speaker	Yes
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS
Cooling Solutions	Air cooled forced convection
Power Supply Fans	1 - 92mm
CPU Heatsink Fan	1st CPU: 1 - 92mm Optional 2nd CPU: 1 - 92mm
Memory Heatsink Fan	System Board Memory: rear bank: 1 - 60mm, front bank: 1 - 40mm Optional 2nd CPU/Memory Module: rear bank: 1 - 80mm.
HP Vision Diagnostics Offline Edition	HP Vision Diagnostics Offline Edition The diagnostics utility enables you to perform testing and to view critical computer hardware and software configuration information from various sources. This utility enables you to: • Run diagnostics • View the hardware configuration of the system
	DA - 14262 Worldwide QuickSpecs — Version 4 — 4.1.2012 Page 2

Cyclem recommodic	specime discre		
	Key features and benefits HP Vision Diagnostics simplifies the process of effectively identifying, diagnosing, and isolating the hardware issues. In addition to robust management tools, service tools can be invaluable in quickly resolving system problems. To streamline the service process and resolve problems quickly, it is necessary to have the right information available at the time that a service call is placed. The primary information requirement, which is also the one that provides the greatest Vision into potential system issues, is the configuration of the system. Vision diagnostics helps provide higher system availability. Typical uses of the Vision Diagnostics are: • Testing and diagnosing apparent hardware failures • Documenting system configurations for upgrade planning, standardization, inventory tracking, disaster recovery, and maintenance • Sending configuration information to another location for more in-depth analysis		
Access Panel Key Lock	Yes, prevents removal of the access panel and all internal components including devices installed in the external 5.25" bays.		
ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system		
Trusted Platform Module Chip with optional ProtectTools Software	Yes, Infineon SLB9635TT1.2		
Integrated Chassis Handles	Yes		
Power Supply	Tool-less. Includes integrated handle.		
PCI Card Retention	Yes, tool-less Rear (all) Middle (full-height cards) Front (full-length cards with extender)		
Flash ROM	SPI ROM		
Diagnostic Power Switch LED on board	Yes		
Clear Password Jumper	Yes		
Clear CMOS Button	Yes		
CMOS Battery Holder	Yes		
DIMM Connectors	Yes		
HP ProtectTools Security Manager	Yes - Not supported on Linux		

BIOS			
BIOS 32-bit Services	Standard BIOS 32-Bit Service Directory Proposal v0.4		
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces		
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0		
BBS	BIOS Boot Specification v1.01		
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.		



System rechnical c	Specifications		
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot		
BIOS Power On	Users can define a specific date and time for the system to power on		
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS		
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM		
Replicated Setup	Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).		
SMBIOS	System Management BIOS 2.7 for system management information		
Boot Control	Disables the ability to boot from removable media on supported devices		
Memory Change Alert	Alerts management console if memory is removed or changed		
Thermal Alert	Monitors the temperature state within the chassis. Three modes:		
	 NORMAL - normal temperature ranges. ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs. 		
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console		
ACPI (Advanced Configuration and Power Management Interface)	Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems.		
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen		
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location		
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time		
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system		
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.		
System board revision level	Allows management SW to read revision level of the system board Revision level is digitally encoded into the HW and cannot be modified		
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing		
Auto Setup when new hardware installed	System automatically detects the addition of new hardware		
Keyboard-less Operation	The system can be booted without a keyboard		
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings		
Asset Tag	Allows the user or MIS to set a unique tag string in non-volatile memor		



System Technical Specifications

Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually		
Adaptive Cooling	Fan control parameters are set according to detected hardware configuration for optimal acoustics		
Pre-boot Diagnostics	Early (pre-video) critical errors are reported via beeps and blinks on the power LED		
Industry Standard Specification Support			
Industry Standard	Revision Supported by the BIOS		
ACPI	Advanced Configuration and Power Management Interface, Version 2.0		
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b		
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0		
EDD	 Enhanced Disk Drive Specification Version 1.1 BIOS Enhanced Disk Drive Specification Version 3.0 		
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0		
PCI	 PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft 0.7 		
PCI Express	PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0		
PMM	POST Memory Manager Specification, Version 1.01		
SATA	 Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0 		
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2		
TPM	Trusted Computing Group TPM Specification Version 1.2		
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1		
USB	Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.0 Specification		
SMBIOS	System Management BIOS Reference Specification, Version 2.7		
)—————————————————————————————————————			

Social and Environmental Responsibility

Social allu Elli	Anominental Responsibility	
Eco-Label Certificati	ions This product has received or is in the process of being certified to the following approvals and ma	
& Declarations	be labeled with one or more of these marks:	
	 ENERGY STAR (Configuration dependent, Microsoft Windows only) US Federal Energy Management Program (FEMP) China Energy Conservation Program IT ECO declaration Japan PC Green label* 	
	* This product conforms to the examination standards (2003 version) under JEITA's 'PC Green Label System.'	
Batteries	This product complies with ISO standards:	
	 EU Directive 91/ 157/ EEC EU Directive 93/ 86/ EEC EU Directive 98/ 101/ EEC 	
	Batteries used in the product do not contain:	



System Technical Specifications

Mercury greater than 5ppm by weightCadmium greater than 10ppm by weight

• Lead greater than 4,000ppm by weight.

Battery size: CR2032 (coin cell)

Battery type: Lithium

Restricted Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refe to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen specifications.html):

- Asbestos
- Batteries Mercury
- Batteries Cadmium
- Batteries Lead (non-rechargeable)
- Batteries Non-rechargeable Alkaline and Carbon-Zinc Batteries
- Batteries Classification as "Not Restricted" for Transport
- Brominated Flame Retardants (PBBs, PBDEs, including DecaBDE)
- Brominated Flame Retardants (all BFRs in external case plastic parts)
- · Cadmium and its compounds
- Certain Azo Colorants
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Formaldehyde emissions
- Hexavalent Chromium and its compounds in metallic applications
- Hexavalent Chromium and its compounds in non-metallic applications
- · Lead and its compounds
- Lead in paint
- Lead in Polyvinyl Chloride (PVC) coating of external cables, wires and cords
- Mercury and its compounds
- Nickel on external surfaces
- Ozone Depleting Substances (ODS)
- Polycyclic Aromatic Hydrocarbons (PAH)
- Perfluorooctane sulfonates (PFOS) in parts
- Perfluorooctane sulfonates (PFOS) in preparations
- Polychlorinated Biphenyls (PCBs) and Polychlorinated Terphenyls (PCTs)
- Polychlorinated Naphthalenes
- Polyvinyl Chloride (PVC) in external case plastic parts
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

BFR/PVC-Free Statement

Configurations of the HP Z620 Workstation where SAS 3 ½" HDDs, Intel SAS Controller Module, Creative Recon3D PCIe Audio Card, Broadcom 5761 Gigabit PCIe NIC, or LSI 9260-8i SAS 6Gb/ROC RAID Card are not selected are brominated flame retardant and polyvinyl chloride free (BFR/PVC-free), meeting the evolving definition of "BFR/PVC-free" as set forth in the iNEMI Position Statement on the Definition of Low-Halogen Electronics (BFR/CFR/PVC-Free). http://thor.inemi.org/webdownload/projects/ese/HFR-Free/Low-Halogen_Def.pdf

End-of-Life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

Hewlett-Packard Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report: http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications:

http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html

ISO 14001 certificates:



	http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html				
Additional Information	This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC.				
	 This HP product is designed to comply with the Waste Electrical and Electronic Equipmer (WEEE) Directive - 2002/96/EC. 				
	 Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043. 				
	This product contains 0% recycled materials (by wt.)				
	This product is >90% recycle-able when properly disposed of at end of life.				
Packaging	HP Workstation product packaging meets the following (refer to the HP General Specification for the Environment (http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf)				
	 Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment (see link above). 				
	Does not contain ozone-depleting substances (ODS).				
	 Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in exce- of 100 ppm sum total for all heavy metals listed. 				
	 Maximize the use of post-consumer recycled content materials in packaging materials. All packaging material is recyclable. 				
	All packaging material is designed for ease of disassembly.				
	Reduce size and weight of packages to improve transportation fuel efficiency.				
	 Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards. 				
Packaging Materials					
Internal	LDPE Foam and Bag: 0.5 kg				
External	Cardboard carton and insert: 1.5 kg				

Manageability		
Industry Standard Specifications	This product meets the following industry standard specifications for manageability functionality • DASH 1.1 required functionalities via Intel LAN on motherboard	
Intel Active	Intel Active Management Technology (AMT) 7.0	
Management		
Technology (AMT)	An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 7.0 includes the following advanced management functions:	
	 Power Management (on, off, reset) Hardware Inventory (includes BIOS and firmware revisions) Hardware Alerting Agent Presence System Defense Filters SOL/IDER Cisco NAC/SDN Support ME Wake-on-LAN DASH 1.1 compliance 	
	 IPv6 Support Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIO screen, periodic connections, or alert triggered connection Remote Scheduled Maintenance - pre-schedule when the system connects to the IT or service provider console for maintenance. Remote Alerts - automatically alert IT or service provider if issues arise Access Monitor - Provides oversight into Intel® AMT actions to support security requirements PC Alarm Clock Microsoft NAP Support Host Base set-up and configuration 	

	Management Engine (ME) firmware roll back			
Intel® vPro™	The HP Z620 Workstation supports Intel vPro technology when configured as outlined below:			
Technology				
	 Intel Xeon processor E5-1600 product family or E5-2600 product family featuring Intel vPro 			
	Technology			
	Intel C602 chipset			
	Intel 82579LM GbE LAN			
Remote Manageability	The HP Z620 Workstation is supported on the following remote manageability software con			
Software Solutions				
	LANDesk Management Suite (HP recommended solution)			
	Microsoft System Center Configuration Manager			
	HP Client Automation Enterprise			
	For questions or support for manageability needs, please visit http://www.hp.com/go/easydeploy			
System Software	For questions or support for SSM, please visit: http://www.hp.com/go/ssm			
Manager	geranning or cappearant com, product manning manning around			
Service, Support, and	On-site Warranty and Service (Note 1): Three-years, limited warranty and service offering delivers			
Warranty	on-site, next business-day (Note 2) service for parts and labor and includes free telephone support			
y	(Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one countr			
	and transferred to another, non-restricted country will remain fully covered under the original			
	warranty and service offering.			
	The state of the s			
	NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply.			
	NOTE 2: On-site service may be provided pursuant to a service contract between HP and an			
	authorized HP third-party provider, and is not available in certain countries. Global service			
	response times are based on commercially reasonable best effort and may vary by country.			
	NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-			
	party hardware and software. Toll-free calling and 24x7 support service may not be available in			
	some countries.			
	HP Care Pack Services extend service contracts beyond the standard warranties. Service starts			
	from date of hardware purchase. To choose the right level of service for your HP product, use the			
	HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Additional HP Care			
	Pack Services information by product is available at: http://www.hp.com/hps/carepack. Service			
-	levels and response times for HP Care Packs may vary depending on your geographic location.			
Product Change	Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories because it as explanation of the product Change Notifications (PCNs) and Customer			
Notification	Advisories by email to customers, based on a user-defined profile.			
	PCNs provide advance notification of hardware and software changes to be implemented in			
	the factory providing time to plan for transition.			
	Customer Advisories provide concise, effective problem resolution, greatly reducing the			
	need to call technical support.			



Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduct this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

	that same comigu	ration throughout the inecycle of the product.
Processors	Product #	Offering
	A2A06AV	Intel Xeon E5-2620 2 15M 1333 6C 1 CPU
	A2A19AV	Intel Xeon E5-2620 2 15M 1333 6C 2 CPU
	A2A09AV	Intel Xeon E5-2643 3.3 10M 1600 4C 1 CPU
	A2A22AV	Intel Xeon E5-2643 3.3 10M 1600 4C 2 CPU
Hard Drives	Product #	Offering
	QG001AV	500GB 7200 RPM SATA 1st HDD
	QG011AV	500GB 7200 RPM SATA 2nd HDD
	QG021AV	500GB 7200 RPM SATA 3rd HDD
	QG031AV	500GB 7200 RPM SATA 4th HDD
	QG002AV	1TB 7200 RPM SATA 1st HDD
	QG012AV	1TB 7200 RPM SATA 2nd HDD
	QG022AV	1TB 7200 RPM SATA 3rd HDD
	QG032AV	1TB 7200 RPM SATA 4th HDD
Graphics	Product #	Offering
	A7U49AV	NVIDIA NVS 310 512MB GFX
	A7U50AV	NVIDIA NVS 310 512MB 2nd GFX
	A7U51AV	NVIDIA NVS 310 512MB 3rd GFX
	A7U52AV	NVIDIA NVS 310 512MB 4th GFX
Memory	Product #	Offering
·		Any configuration with 2GB DDR3-1600 ECC Unbuffered DIMMs
		Any configuration with 4GB DDR3-1600 ECC Unbuffered DIMMs
		Any configuration with 4GB DDR3-1600 ECC Registered DIMMs
		Any configuration with 8GB DDR3-1600 ECC Registered DIMMs
Optical and Remo	vableProduct #	Offering
Storage	QG049AV	16X SuperMulti DVDRW SATA 1st ODD
	QG053AV	16x SuperMulti DVDRW SATA 2nd ODD
Input Devices	Product #	Offering
	A8Z53AV	HP USB Keyboard (available June 2012)
	A8Z55AV	HP USB Optical Mouse (available June 2012)



Stable & Consistent Offerings

Operating Systems

Product # LJ454AV

Offering

Windows 7 Professional 64-bit OS



Technical Specifications - Processors

Processors

Intel® Xeon® Processor E5-2603 4C 1.80GHz Intel® Xeon® Processor E5-2609 4C 2.40GHz Intel® Xeon® Processor E5-2620 6C 2.00GHz Intel® Xeon® Processor E5-2630 6C 2.30GHz Intel® Xeon® Processor E5-2640 6C 2.50GHz Intel® Xeon® Processor E5-2643 4C 3.30GHz Intel® Xeon® Processor E5-2650 8C 2.00GHz Intel® Xeon® Processor E5-2660 8C 2.20GHz Intel® Xeon® Processor E5-2665 8C 2.40GHz Intel® Xeon® Processor E5-2667 6C 2.90GHz Intel® Xeon® Processor E5-2670 8C 2.60GHz Intel® Xeon® Processor E5-2680 8C 2.70GHz Intel® Xeon® Processor E5-2690 8C 2.90GHz Intel® Xeon® Processor E5-1660 6C 3.30GHz Intel® Xeon® Processor E5-1650 6C 3.20GHz Intel® Xeon® Processor E5-1620 4C 3.60GHz Intel® Xeon® Processor E5-1607 4C 3.00GHz Intel® Xeon® Processor E5-1603 4C 2.80GHz

Processor Note

For detailed processor specifications, please refer to the Overview section at the beginning of this document.

Z620 Xeon E5-2603 4C 1.80 10MB 1066 CPU2	A6S72AA
Z620 Xeon E5-2609 4C 2.40 10MB 1066 CPU2	A6S73AA
Z620 Xeon E5-2620 6C 2.00 15MB 1333 CPU2	A6S74AA
Z620 Xeon E5-2630 6C 2.30 15MB 1333 CPU2	A6S75AA
Z620 Xeon E5-2640 6C 2.50 15MB 1333 CPU2	A6S76AA
Z620 Xeon E5-2643 4C 3.30 10MB 1600 CPU2	A6S77AA
Z620 Xeon E5-2650 8C 2.00 20MB 1600 CPU2	A6S78AA
Z620 Xeon E5-2660 8C 2.20 20MB 1600 CPU2	A6S79AA
Z620 Xeon E5-2665 8C 2.40 20MB 1600 CPU2	A6S80AA
Z620 Xeon E5-2667 6C 2.90 15MB 1600 CPU2	A6S81AA
Z620 Xeon E5-2670 8C 2.60 20MB 1600 CPU2	A6S82AA
Z620 Xeon E5-2680 8C 2.70 20MB 1600 CPU2	A6S83AA
Z620 Xeon E5-2690 8C 2.90 20MB 1600 CPU2	A6S84AA

Technical Specifications - Hard Drives

HP SAS (Serial Attached SCSI) Hard Drives for HP Workstations 600GB SAS 15K rpm 6Gb/s 3.5" HDD Capacity600GBHeight1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

InterfaceSASSynchronous Transfer6.0 Gb/s

Rate (Maximum)

Buffer 16 MB

Seek Time (typical
reads, includes controller
overhead, including
settling)Single Track
Average
Full Stroke0.2 ms3.4 ms
6.6 ms

Rotational Speed 15,000 rpm

Logical Blocks 1,172,123,568 - 512 byte blocks **Operating Temperature**50° to 95° F (10° to 35° C)

450GB SAS 15K rpm 6Gb/s 3.5" HDD Capacity 450GB Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface SAS
Synchronous Transfer 6Gb/s

Rate (Maximum)

Buffer 16MB

Seek Time (typical
reads, includes controller
overhead, including
settling)Single Track
Average
Full Stroke0.2 ms3.4 ms
6.6 ms

Rotational Speed 15,000 rpm

Operating Temperature 50° to 95° F (10° to 35° C)

300GB SAS 15K rpm 6Gb/s 3.5" HDD
 Capacity
 300GB

 Height
 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface SAS
Synchronous Transfer 6Gb/s
Rate (Maximum)

Buffer 16MB

Seek Time (typical
reads, includes controller
overhead, including
settling)Single Track
Average
Full Stroke0.2 ms3.4 ms6.6 ms

Rotational Speed 15,000 rpm

Operating Temperature 50° to 95° F (10° to 35° C)

HP 300GB SAS 10K SFF HDD

Capacity Height 300GB 0.6 in; 1.53 cm



Technical Specifications - Hard Drives

Width Media Diameter 2.5 in; 6.36 cm

Physical Size 2.75 in; 6.99 cm

Interface SAS 6Gb/s
Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 64MB

Cachemulti-segmentable cache bufferSeek Time (typical reads, includes controllerSingle Track Average0.4 ms (max)Average3.6 ms

overhead, including

settling) Full Stroke 7.3 ms

Rotational Speed 10,000 rpm Logical Blocks 585,937,500

Operating Temperature41° to 131° F (5° to 55° C)

HP 600GB SAS 10K SFF HDD Capacity 600GB

Height 0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm

Physical Size 2.75 in; 6.99 cm

7.3 ms

Interface SAS 6Gb/s
Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 64MB

 Cache
 multi-segmentable cache buffer

Seek Time (typical Single Track 0.4 ms (max) reads, includes controller Average overhead, including 3.6 ms

settling) Full Stroke
Rotational Speed 10,000 rpm

Logical Blocks 1,172,123,568

Operating Temperature41° to 131° F (5° to 55° C)

SATA (Serial ATA) Hard3.0TB SATA 7200 rpm Drives for HP 6Gb/s 3.5" HDD

Workstations

 Capacity
 3.0TB

 Height
 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4.0 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 6.0 Gb/s

Rate (Maximum)

Buffer 64MB

Seek Time (typical
reads, includes controller
overhead, includingSingle Track
Average0.6 ms11 ms

settling) Full Stroke Not Specified

Rotational Speed 7,200 rpm

Operating Temperature41° to 140° F (5° to 60° C)

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 2.0TB Height 1 in; 2.54 cm



Technical Specifications - Hard Drives

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm
Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer Up to 600 MB/s

Rate (Maximum)

Buffer 64MB

Seek Time (typical
reads, includes controller
overhead, including
settling)Single Track
Average1.0 msAverage
Full Stroke11 ms

Rotational Speed 7,200 rpm Logical Blocks 3,907,029,168

Operating Temperature41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD Capacity 1 Terabyte (1000 GB)

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4.0 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600 MB/s

Rate (Maximum)

Buffer 32MB

Seek Time (typical
reads, includes controller
overhead, including
settling)Single Track
Average2 ms11 ms
Full Stroke21 ms

Rotational Speed 7,200 rpm Logical Blocks 1,953,525,168

Operating Temperature41° to 131° F (5° to 55° C)

500GB SATA 7200 rpm Capacity 6Gb/s 3.5" HDD Height

Capacity 500GB Height 1 in; 2.5 cm

Width Media Diameter 3.5 in; 8.9 cm Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 16 MB

Seek Time (typical
reads, includes controller
overhead, including
settling)Single Track
Average2 ms411 ms521 ms

Rotational Speed 7,200 rpm **Logical Blocks** 976,773,168

Operating Temperature41° to 131° F (5° to 55° C)

250GB SATA 7200 rpm Capacity 250 GB **6Gb/s 3.5" HDD Height** 1 in; 2.54 cm



Technical Specifications - Hard Drives

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4.0 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 8 MB

Seek Time (typical
reads, includes controller
overhead, including
settling)Single Track
Average2 ms11 ms
Full Stroke21 ms

Rotational Speed 7,200 rpm Logical Blocks 488,397,168

Operating Temperature41° to 131° F (5° to 55° C)

HP Solid State Drives for Workstations

HP 160GB SATA SSD

Capacity 160GB

Width Media Diameter NaN in; NaN cm

Physical Size 2.5 in; 6.36 cm

Interface SATA
Synchronous Transfer 3Gb/s

Rate (Maximum)

Operating Temperature32° to 158° F (0° to 70° C)

HP 300GB SATA SSD

Capacity 300GB

Width Physical Size 2.5 in; 6.36 cm

InterfaceSATASynchronous Transfer3Gb/s

Rate (Maximum)

Operating Temperature32° to 158° F (0° to 70° C)



Technical Specifications - Hard Drive Controllers

LSI 9212 4-Port SAS 6Gb/s RAID Card PCI Bus 8-lane, 5GT/s PCI Express 2.0

PCI Modes Bus Master DMA RAID Levels RAID 0, 1, 1E and 10

PCI Data Burst Half Duplex, x4 PCIe 2000 MB/s Transfer Rate Full Duplex, x8 PCIe 4000 MB/s

SAS Bandwidth Half Duplex Single lane - 600 MB/s

Wide Port (2 lanes) - 1200 MB/s Wide Port (4 lanes) - 2400 MB/s

Full Duplex Single SAS Lane - 1200 MB/s

Wide Port (2 lanes) -2400 MB/s Wide Port (4 lanes) - 4800 MB/s

PCI Card Type3.3V Add-in cardPCI Voltage $12 V \pm 10\%$ PCI Power<13.5 Watts

Bracket Full height and Low-profile

None

256

Certification Level PCI-Express 2.0

IO Bus 1x4 6Gb/s SAS ports

SAS Processor LSISAS2004 Internal Connectors Four x1 SATA

External Connectors Maximum Number of

SCSI Devices

LED Indicators Internal

Activity/Fault per x4 port - Heartbeat

LSI MegaRAID® 9260-8iPCI Bus PCI-Express (Gen2) V2.0 x8 lanes

SAS 6Gb/s ROC RAID Card and iBBU08 Battery Backup Unit

PCI Modes Bus Master DMA
RAID Levels RAID 0, 1, 5, and 6

RAID spans 10, 50 and 60

PCI Data Burst Up to 4GB/s Transfer Rate

PCI Card Type Low profile, single PCIe slot design with full height bracket.

The optional iBBU08 Battery Backup unit mounts on the controller care

and the assembly remains within a single PCIe slot width.

PCI Voltage +3.3V Add-in Card

PCI Power 12.5 Watts
Certification Level PCI-Express 2.0

IO Bus Eight 3 Gb/s and 6Gb/s compatible SAS/SATA ports

Internal Connectors Two SAS SFF8087 x4

External Connectors None Maximum Number of 32.

SCSI Devices
NOTE: HP Workstations do not support this many internal drives.

LED Indicators
Connector LEDs indicate whether the internal connector is active for

ports 0-3 and 4-7



Technical Specifications - Graphics

AMD FirePro 2270 512MB Graphics Card **Form Factor** Low Profile, Half Length, 2.3" x 6.6"

Graphics Controller AMD FirePro™ 2270 Professional Graphics

Bus Type PCI Express™ x16 Generation 2.0

Memory **512MB DDR3**

Connectors DMS-59 connector to support breakout cables for dual DisplayPort, D\

and VGA output.

DMS-59 to Dual DVI adapter included.

(Display Port and VGA adapters sold separately)

Maximum Resolution Digital 2560x1600 (DisplayPort)

Analog 1920x1200 (DVI 60 Hz/ VGA 75Hz)

RAMDAC 400 MHz DAC, 10-bit per channel **Display Output** Card supports up to two displays

Supported Graphics

APIs

DirectX 11 and OpenGL 4.0

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Power Consumption 17W Maximum

NVIDIA NVS 300 512MB Form Factor

Graphics Card

Graphics Controller

NVIDIA NVS 300 Graphics Board Bus Type PCI Express x16, Generation 2.0

Memory 512 MB GDDR3 SDRAM unified graphics memory

Connectors DMS-59

Includes DMS-59 to Dual DVI-I adapter

2.7 inches (H) x 5.7 inches (L), Half-Height

DMS-59 to Dual DisplayPort adapter and DMS-59 to Dual VGA adapte

available as an option

DMS-59 to Dual DisplayPort adapter required for HP ZR30w Display

Maximum Resolution DVI: two digital displays up to 1920 x 1200

> DisplayPort: two digital displays up to 2560 x 1600 VGA: two analog displays up to 1920 x 1080

Image Quality Features

Display Output

This card support up to two displays:

 Drives DVI enabled digital displays at resolutions up to 1920 x 1200 at 60 Hz with reduced blanking

• Drives DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking (through optional

DMS-59 to DisplayPort adapter)

Drives VGA enabled analog displays at resolutions up to 1920 x 1080 (through optional DMS-59 to VGA adapter)

Supported Graphics

APIs

OGL 3.3 DirectX 10.1

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation



Technical Specifications - Graphics

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption <18 Watts

NVIDIA NVS 310 512MB Form Factor Low Profile:

Graphics Card

2.713 inches in height × 6.150 inches in length

Graphics Controller NVIDIA NVS 310

Bus Type PCI Express x16, 2.0 compliant

Memory Size: 512MB DDR3

Clock: 875Mhz

Memory Bandwidth: 14GB/s

Connectors 2 x DisplayPort 1.2

Maximum Resolution Up to 2560 x 1600 (digital display) per display.

Image Quality Features See Display Output section.

The following video formats are supported:

- MPEG2

- MPEG4 Part 2 Advanced Simple Profile

- H.264 SVC codec support - Support for 3D Blu Ray

- VC1

- DivX version 3.11 and later

- MVC

A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 310 GPU provides hardware acceleration for the computationally intensive parts of video processing as well as provides improved video playback speeds via faster decode and transcode.

Display Output Up to 2 displays in the following configurations:

DisplayPort output:

- Drives two DisplayPort enabled digital display at resolutions up t 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card
- Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz wir reduced blanking using DisplayPort 1.2 multi stream topology technology.

DVI-D output:

- Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors
- Drives two digital display at resolutions up to 2560× 1600 at 60 F with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors

HDMI output:



Technical Specifications - Graphics

• NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors

VGA display output:

 Drives two analog display at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors

Shading Architecture Supported Graphics

Shader Model 5.0 DX11, OpenGL 4.1

APIs

Available Graphics Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption

Note

19.5 Watts

The thermal solution used on this card is an active fan heatsink.

NVIDIA Quadro NVS 450 512 MB PCIe **Graphics Card**

Form Factor ATX Full Height, 1/2 length

Passive cooling

PCI Express x16, Generation 2.0 **Bus Type** Memory 512 MB GDDR3 (256MB per GPU)

Connectors Four DisplayPort;

Four DisplayPort to DVI-D adapters included.

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters

available as an accessory)

Maximum Resolution DisplayPort connectors support ultra-high-resolution panels (up to 256)

x 1600)

NOTE: This card supports up to four displays

Supported Graphics

APIs

OpenGL 3.0 DirectX 10.0

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Microsoft Windows Vista (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption <40 Watts



Technical Specifications - Graphics

NVIDIA Quadro 410 512MB Graphics

Form Factor Low Profile:

2.713 inches × 5.7 inches, single slot

Graphics Controller NVIDIA Quadro 410

Bus Type PCI Express x16, 3.0 compliant

Memory Size: 512MB DDR3
Clock: 900MHz

Memory Bandwidth: 14GB/s

Connectors One dual-link DVI-I connector One DisplayPort connector

Maximum Resolution Up to 2560 x 1600 (digital display) per display.

RAMDAC 400 MHz integrated RAMDAC

Display Output Maximum resolution over DisplayPort: 2560 × 1600 × 32 bpp at 60 Hz

(reduced blanking)

Maximum resolution over DVI port: 2560 × 1600 × 32 bpp at 60 Hz

(reduced blanking)

Maximum resolution over VGA (through DVI to VGA cable): 2048 × 153

× 32 bpp at 85 Hz

Shading Architecture

Supported Graphics

APIs

Shader Model 5.0 DX11, OpenGL 4.2

Available Graphics

Drivers

Memory

Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers

are available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

NVIDIA Quadro 600 1GB Graphics Card **Form Factor** 2.731" H x 6.6" L

Single Slot

Small Form Factor

Graphics Controller NVIDIA Quadro 600 Graphics Card

Bus Type PCI Express 2.0 x16

1 GB GDDR3

128-bit

Connectors 1 DVI-I output, 1DisplayPort output

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI adapters

available as accessories

Maximum Resolution DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz)

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

Shading Architecture Shader Model 5.0



Technical Specifications - Graphics

Supported Graphics

APIs

OpenGL 4.0 DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 3:

bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption 40 Watts

AMD FirePro V3900 1GB Graphics Card Form Factor

Full height, half length (full-height bracket included)

Graphics Controller

AMD FirePro™ V3900 professional graphics

Bus Type

PCI Express® x16, Generation 2.1 1GB DDR3 memory

Memory

1 DL DVI, 1 DP output

Connectors

One DP to DVI adapter included

Maximum Resolution

2560x1600 per display (5120x1600 max. horizontal resolution)

Display Output

1 DisplayPort® 1.2

1 Dual-link DVI

Supported Graphics

APIs

OpenCL™ 1.1, DirectX® 11 and OpenGL 4.2

Available Graphics

Drivers

Genuine Windows® 7 Professional (64-bit and 32-bit)
Genuine Windows Vista® Business (64-bit and 32-bit)
Missesett® Windows XD® Professional (64-bit and 33-bit)

Microsoft® Windows XP® Professional (64-bit and 32-bit)

Linux®* (32-bit or 64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Power Consumption

<50W

Note

AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connectc and/or certified DisplayPort™ active or passive adapters to convert you monitor's native input to your card's DisplayPort™ or Mini-DisplayPort¹ connector(s) may be required. See www.amd.com/firepro for details.



Technical Specifications - Graphics

AMD FirePro V4900 1GB Graphics Card Form Factor Full height (4.37 in), half length (6.61 in)

Graphics Controller AMD FirePro™ V4900 Professional Graphics

Bus Type PCI Express™ x16, Generation 2.1

Memory 1GB GDDR5

Connectors 2 DisplayPort, 1 dual link DVI Output, One DP to DVI adapter included

Maximum Resolution Up to three digital displays at resolutions up to 2560 x 1600 @ 60Hz o up to three analog displays, one at resolutions up to 2048 x 1536 @

85Hz, plus two resolutions up to 1920 x 1200 @ 60Hz (165 MHz dot clock) Note: This card supports up to three displays with Windows 7,

Vista or Linux, and up to two displays on XP

RAMDAC

Image Quality Features Up to 3 independent outputs with ATI Eyefinity technology support

(More information at:

www.amd.com/us/products/technologies/eyefinity/). Full 30-bit display pipeline. Advanced video capabilities, including high fidelity gamma, color correction and scaling. Dedicated hardware (UVD2) for H.264, VC 1, and MPEG2 decode

NOTE: The use of more than two displays on Linux requires support fo

xrandr 1.2 or greater in the X server.

Supported graphics

APIs

DirectX 11 and OpenGL 4.1.

OpenCL 1.2 DirectCompute 11

Available graphics

drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Linux®2 (32-bit or 64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site.

Power Consumption

Note

<75W

1. AMD Eyefinity technology can support multiple displays using a sin enabled AMD FirePro[™] professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort[™] connecte and/or certified DisplayPort[™] active or passive adapters to convert you monitor's native input to your card's DisplayPort[™] or Mini-DisplayPort[™] connector(s) may be required. See www.amd.com/firepro for details. 2. Linux® drivers can be downloaded from support.amd.com



Technical Specifications - Graphics

NVIDIA Quadro 2000 1GB Graphics Card **Form Factor** 4.376" H x 7" L

Single Slot

Graphics Controller

NVIDIA Quadro 2000 Graphics Card

Bus Type

PCI Express 2.0 x16

Memory 1 GB GDDR5

128-bit

Connectors 1 DVI-I output, 2 DisplayPort outputs

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI adapters

available as accessories

Maximum Resolution Dual Di

Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120H:

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

Image Quality Features

• Up to 16K x16K texture and render processing

Transparent multisampling and super sampling

• 16x angle independent anisotropic filtering

• 128-bit floating point performance

• 32-bit per-component floating point texture filtering and blending

Support for any combination of two connected displays
 Display Part 4.4s. LIDMI 4.3s. and LIDCR support

DisplayPort 1.1a, HDMI 1.3a, and HDCP support

NVIDIA® 3D Vision™ technology, 3D DLP, Interleaved, and othe

3D stereo format support

Full OpenGL quad buffered stereo support

Underscan/overscan compensation and hardware scaling

NVIDIA® nView® multi-display technology

Shading Architecture

Supported Graphics

APIs

Shader Model 5.0

OpenGL 4.0 DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 3)

bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption

62 Watts



Technical Specifications - Graphics

AMD FirePro V5900 **2GB Graphics Card**

Form Factor Full-height, full length, single slot

Graphics Controller AMD FirePro™ V5900 Professional Graphics

Bus Type PCI Express™ x16, Generation 2.1

Memory 2GB GDDR5

Connectors 2 x Display Port 1.2 1 x Dual-link DVI

One DP to DVI adapter included with card

Maximum Resolution 2560 x 1600

Display Output Up to 3 simultaneous displays (using AMD Eyefinity with Windows 7 c

Linux)

Shader Model 5.0 **Shading Architecture**

Supported Graphics

APIs

DirectX 11 and OpenGL 4.1

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Power Consumption

Note

< 75W

AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connectc and/or certified DisplayPort™ active or passive adapters to convert you monitor's native input to your card's DisplayPort™ or Mini-DisplayPort¹ connector(s) may be required. See www.amd.com/firepro for details.

AMD FirePro V7900 **2GB Graphics Card**

Form Factor Full height, full length, single slot

AMD FirePro™ V7900 Professional Graphics **Graphics Controller**

Bus Type PCI Express™ x16, Generation 2.1

Memory 2GB GDDR5 Connectors 4 x DisplayPort 1.2

Two DP to DVI adapters included with card

Maximum Resolution 2560 x1600

Display Output Up to 4 simultaneous displays (using AMD Eyefinity with Windows 7 c

Linux)

Shading Architecture

Shader Model 5.0

Supported Graphics **APIs**

DirectX 11 and OpenGL 4.1

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

< 150W **Power Consumption**



Technical Specifications - Graphics

Note

AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connectc and/or certified DisplayPort™ active or passive adapters to convert you monitor's native input to your card's DisplayPort™ or Mini-DisplayPort¹ connector(s) may be required. See www.amd.com/firepro for details.

NVIDIA Quadro 4000 2GB Graphics Card

Form Factor 4.376" H x 9.50" L

Single Slot

Graphics Controller

NVIDIA Quadro 4000 Graphics Card

Bus Type

PCI Express 2.0 x16

Memory 2 GB GDDR5

256-bit

Connectors 1 DVI-I output, 2 DisplayPort outputs;

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI (single-link of

dual-link) adapters available as accessories (Optional stereo bracket available from 3rd party)

Maximum Resolution

Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120H: Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

RAMDAC 400 MHz integrated RAMDAC

Image Quality Features

- Up to 16K x16K texture and render processing
- Transparent multisampling and super sampling
- 16x angle independent anisotropic filtering
- 128-bit floating point performance
- 32-bit per-component floating point texture filtering and blending
- Support for any combination of two connected displays
- DisplayPort 1.1a, HDMI 1.3a, and HDCP support
- NVIDIA 3D Vision™ technology, 3D DLP, Interleaved, and other 3D stereo format support
- Full OpenGL quad buffered stereo support
- Underscan/overscan compensation and hardware scaling
- NVIDIA nView® multi-display technology

Shading Architecture

Supported Graphics

APIs

Shader Model 5.0 OpenGL 4.0

DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 3:

hit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:



Technical Specifications - Graphics

ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption 142 Watts

NVIDIA Quadro 5000 2.5GB Graphics Card

Form Factor 4.376" H x 9.75" L

Dual Slot

Graphics Controller

NVIDIA Quadro 5000 Graphics Card

Bus Type Memory PCI Express 2.0 x16

2.5 GB GDDR5

320-bit

Connectors DVI-I (1), DP (2), Stereo (1)

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI adapters

available as accessories

Maximum Resolution Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120H:

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

Image Quality Features

Up to 16K x16K texture and render processing

Transparent multisampling and super sampling

• 16x angle independent anisotropic filtering

128-bit floating point performance

• 32-bit per-component floating point texture filtering and blending

Support for any combination of two connected displays

• DisplayPort 1.1a, HDMI 1.3a, and HDCP support

NVIDIA 3D Vision™ technology, 3D DLP, Interleaved, and other

3D stereo format support

Full OpenGL quad buffered stereo support

Underscan/overscan compensation and hardware scaling

NVIDIA nView® multi-display technology

Shading Architecture

Supported Graphics

APIs

Shader Model 5.0

OpenGL 4.0 DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 3)

bit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption 152 Watts



Technical Specifications - Graphics

NVIDIA Quadro 6000 6GB Graphics Card

Form Factor 4.376" H x 9.75" L

Dual Slot

Graphics Controller

NVIDIA Quadro 6000 Graphics Card

Bus Type Memory

PCI Express 2.0 x16

6 GB GDDR5 384-bit

ECC Memory

Connectors 1 DVI-I output, 2 DisplayPort outputs, 1 Stereo(3-pin mini DIN);

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to dual link DVI

adapters available as accessories

Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120H; **Maximum Resolution**

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

Image Quality Features

• 30-bit color

Up to 16K x16K texture and render processing

Transparent multisampling and super sampling

• 16x angle independent anisotropic filtering

• 128-bit floating point performance

• 32-bit per-component floating point texture filtering and blending

• 64x full scene antialiasing (FSAA) / 128x FSAA in SLI Mode

 Support for any combination of two connected displays • DisplayPort 1.1a, HDMI 1.3a, and HDCP support

NVIDIA 3D Vision[™] technology, 3D DLP, Interleaved, and other

3D stereo format support

Full OpenGL quad buffered stereo support

Underscan/overscan compensation and hardware scaling

NVIDIA nView® multi-display technology

Shading Architecture

Supported Graphics

APIs

Shader Model 5.0

OpenGL 4.0 DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 3:

bit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption <250 Watts



Technical Specifications - High Performance GPU Computing

NVIDIA Tesla C2075 Compute Processor **Form Factor** 4.376 inches by 9.75 inches

Dual Slot

System Interface PCI Express Gen2 ×16
Video Outputs One Dual Link DVI-I

(Entry graphics level of performance)

Memory 6GB GDDR5
Peak Memory +170 GB/s
Bandwidth

Supported APIs CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Supported Operating

Systems

Genuine Windows 7 Professional (64-bit) Genuine Windows Vista Business (64-bit) Microsoft Windows XP Professional (64-bit)

Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit)

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

Processor Cores 448 CUDA cores
Power Consumption ~215 Watts

NOTE 1: A 1110W PSU is required for Tesla C2075 on the Z800 NOTE 2: A 600W PSU is required for Tesla C2075 on the Z400 NOTE 3: A 1125W PSU is required for Tesla C2075 on the Z820



Technical Specifications - Multimedia and Audio Devices

HP Thin USB Powered Frequency Response (- FO to 20kHz

Speakers 3dB, 24-bit/96kHz input)

Dimensions Speakers: 14.52 x 9.50 x 2.45 cm (5.72 x 3.74 x 0.96 in) per speaker



Technical Specifications - Optical and Removable Storage

HP DVD-ROM Drive Description 5.25-inch, half-height, tray-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

Disc Capacity DVD-ROM Single layer: Up to 4.7 GB Double layer: Up

8.5 GB

Access Times DVD-ROM Single Layer < 140 ms (typical)

CD-ROM Mode 1 < 125 ms (typical)

Full Stroke DVD < 250 ms (seek)

Full Stroke CD < 210 ms (seek)

Power Source SATA DC power receptacle

DC Power $5 \text{ VDC} \pm 5\%$ -100 mV ripple p-pRequirements $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC - <1000 mA typical, < 1600 mA

maximum

12 VDC - < 600 mA typical, < 1400 mA

5° to 50° C (41° to 122° F)

maximum

10% to 90%

30° C (86° F)

Operating Environmental (all

conditions noncondensing) Temperature

Relative Humidity

Maximum Wet Bulb

Temperature
Operating Systems

Operating Systems Supported Windows 7 Professional 32-bit and 64-bit,

Windows Vista Business 64*, Windows Vist Business 32*, Windows Vista Home Basic

32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6

Desktop/Workstation,

Removed reference to "Novell" because of acquisition and changed product reference to "SUSE Linux Enterprise Desktop 10 & 11", No driver is required for this device. Native support is provided by the operating system.

HP DVD+/-RW Drive

Description 5.25-inch, half-height, tray-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

Disc Formats DVD-RAM

DVD+R DVD+RW DVD+R DL DVD-R DVD-R DVD-RW CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

Full Stroke DVD < 250 ms (seek) Full Stroke CD < 210 ms (seek)



Technical Specifications - Optical and Removable Storage

Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 40X CD-RW Up to 32X	
	DVD ROM Read	DVD-RAM	Up to 12X
		DVD+RW	Up to 8X
		DVD-RW	Up to 8X
		DVD+R DL	Up to 8X
		DVD-R DL	Up to 8X
		DVD-ROM	Up to 16X
		DVD-ROM DL	Up to 8X
		DVD+R	Up to 16X
		DVD-R	Up to 16X
Power	Source	SATA DC power receptacle	
	DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p	
	DC Current	5 VDC - <1000 mA typical, <1600 mA maximum 12 VDC - <600 mA typical, <1400 mA maximum	
Operating Environmental (all conditions non-condensing)	Temperature	5° to 50° C (41° to 122° F)	
	Relative Humidity	10% to 90%	
	Maximum Wet Bulb Temperature	30° C (86° F)	
	Operating Systems Supported	Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vist Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation SUSE Linux Enterprise Desktop 10 & 11	
	Kit Contents	No driver is required for this device. Native support is provided by the operating system. HP SATA SuperMulti DVD Writer Drive, Rox Easy Media Creator software, Intervideo WinDVD Software, installation guide, and DVD+R media.	



Technical Specifications - Optical and Removable Storage

HP Slot Load DVD+/-RW Drive

Description Slim-Line, Slot-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA

Dimensions (WxHxD) 12.7 x 1.2 x 12.9 cm (5 x 0.5 x 5 in)

Disc Formats DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW

CD-R CD-RW

Disc Capacity DVD-ROM 5/9/10/18 G DVD-Single / Dual (PTP, OTP)

(Read Only)

4.7G DVD±R/RW (Read & Write) DVD±R Dual (Read & Write)

80mm DVD

DVD-RAM (Read & Write)

CD-ROM 650 MB CD-ROM (Read Only)

80mm CD

800/700/650/ CD-Recordable (Read & Write) 700/650MB CD-Rewritable (Read & Write) 700/650MB High Speed CD-Rewritable (Rea

& Write)

700/650MB Ultra & Ultra+ Speed CD-

Rewritable (Read & Write)

Full Stroke DVD < 270 ms (seek)
Full Stroke CD < 250 ms (seek)

Maximum Data CD ROM Read Transfer Rates DVD ROM Read

CD-ROM, CD-R and CD-RW Up to 24X DVD-RAM Up to 5X DVD Single layer Up to

8X DVD Dual Layer up to 6X

PowerSourceSATA DC power receptacle

DC Power Requirements

5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC 40 mA typical, 800 mA maximum **Temperature** 5° to 50° C (41° to 122° F)

Operating Environmental (all conditions noncondensing)

Relative Humidity
Operating Systems
Supported

10% to 90%
Windows Vista Business 64*, Windows Vist

Business 32*, Windows Vista Home Basic 32*, Windows XP Professional or Windows

XP Home 32*.

Red Hat Enterprise Linux(RHEL) WS4, 5, 6

Desktop/Workstation,

SUSE Linux Enterprise Desktop 10 & 11, No driver is required for this device. Native support is provided by the operating system.

Kit Contents Factory integrated only. Not available as a k

HP Blu-Ray Writer

Description 5.25-inch, half-height, tray-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

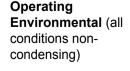
Disc FormatsBD-ROM
BD-R

BD-R BD-RE DVD-RAM DVD+R DVD+RW



Technical Specifications - Optical and Removable Storage

DVD+R DL DVD-R DL DVD-R **DVD-RW** CD-R CD-RW **Disc Capacity** 8.5 GB DL or 4.7 GB standard **DVD-ROM** 50 GB DL or 25 GB standard Blu-ray **Full Stroke DVD** < 250 ms (seek) **Full Stroke CD** < 210 ms (seek) Blu-ray <275 ms (seek) Startup Time (Time to BD-ROM (SL/DL) 25S / 28S drive ready from tray 25S / 28S BD-R (SL/DL) loading) BD-RE (SL/DL) 25S / 28S DVD-ROM (SL/DL) 18S / 18S DVD-R (SL/DL) 25S / 25S **DVD-RW** 25S DVD+R (SL/DL) 25S / 25S **DVD+RW 25S DVD-RAM** 45S CD-ROM 45S **Maximum Data CD ROM Read** CD-ROM Up to 40X **Transfer Rates** Up to 40X CD-R CD-RW Up to 40X **DVD ROM Read DVD-RAM** Up to 5X DVD+RW Up to 10X **DVD-RW** Up to 10X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 16X DVD-ROM DL Up to 8X DVD+R Up to 12X DVD-R Up to 12X Blu-Ray **BD-ROM** Up to 6X **BD-ROM DL** Up to 4.8X BD-R Up to 6X BD-R DL Up to 4.8X BD-R Up to 6X BD-RE SL/DL Up to 4.8X **Power** Source SATA DC power receptacle **DC Power** 5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 10%-100 mV ripple p-p Requirements **DC Current** 5 VDC -900 mA typical, 1200 mA maximum 12 VDC -1000 mA typical, 1600 mA maximu



Temperature Relative Humidity Maximum Wet Bulb Temperature

Operating Systems

5° to 50° C (41° to 122° F) 15% to 80%

30° C (86° F)

Windows 7 Professional 32-bit and 64-bit,



Technical Specifications - Optical and Removable Storage

Supported

Windows Vista Business 64*, Windows Vist Business 32*, Windows Vista Home Basic

32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, (

Desktop/Workstation,

SUSE Linux Enterprise Desktop 10 & 11

* No driver is required for this device. Native support is provided by the operating system.

** RHEL WS4 not supported on

Z200/Z200SFF

Kit Contents HP Blue Laser RW Drive, Roxio Easy Media

Creator software, Intervideo WinDVD

Software, installation guide.

Disclaimer

As Blu-Ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-Ray titles to play, the may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this

workstation.

HP 22-in-1 Media Card Description

Reader

The Media Card Reader device uses the same physical form factor and mounting as a Floppy Disk Drive. The device connects to a 2x5 two-channel USB header on the motherboard of the system. There is no USB controller card provided. Please see the Disc Formats section

below for a list of flash memory card formats that are supported.

The Media Card Reader can be mounted in a dedicated Floppy Drive

bay (if the chassis provides one) or in an appropriate Optical Bay

adapter. It will operate in any orientation.

Interface Type USB 2.0 (one channel dedicated to the separate USB port; one ch

dedicated to the flash memory card slots)

Dimensions (WxHxD) 124.5 x 101.6 x 25.4 mm (4.9 x 4.0 x 1.0 in)

Disc Formats xD-Picture Micro SD

Mounting Orientation

Micro SDHC

SD SDHC SDXC Mini SD Mini SDHC

MultiMediaCard (MMC)

Reduced Size MultiMediaCard (RS MMC)

MultiMedia Card 4.2 (MMC Plus, including MMC Plus HC)

Reduced Size MultiMedia Card 4.2 (MMC Mobile, including MMC Mob

HC)

CompactFlash Card Type I CompactFlash Card Type II

MicroDrive

Memory Stick (MS)

MagicGate Memory Stick (MG) MagicGate Memory Stick Duo

Memory Stick Select

Memory Stick Duo (MS Duo)



Technical Specifications - Optical and Removable Storage

Memory Stick PRO (MS PRO)

Memory Stick PRO Duo (MS PRO Duo)

Memory Stick PRO-HG Duo

Two additional formats are usable with adapters (not supplied):

MMC Micro

Memory Stick Micro (M2)

HP DX115 Removable Interface Type Drive Enclosure

Dimensions (WxHxL)

Weight

Compatible with SAS or SATA controllers

147.6 x 41.1 x 205 mm (5.81 x 1.62 x 8.08 in)

Frame and Carrier: 1.73 kg (3.8 lbs)

Carrier: 0.45 kg (1 lbs)



Technical Specifications - Controller Cards

HP IEEE 1394b
FireWire PCle Card

Data Transfer Rate Supports up to 800 Mbps

Devices Supported IEEE-1394 compliant devices

Bus Type PCIe card full height PCIe slots

Ports Two IEEE-1394b bilingual 9-Pin connectors (Rear)

Internal Connectors One 10-Pin Header connector

System Requirements Windows 7 Professional 32-bit and 64-bit, Microsoft® Windows® XP

Professional, Windows XP Home, Windows Vista. Not supported on Linux. Pentium® III or higher processor 128-MB RAM 1-GB Hard Drive

CD-ROM drive Built in sound system Available PCI slot

Temperature – Operating

50° to 131° F (10° to 55° C)

Temperature - Storage -22° to 140° F (-30° to 60° C)

Relative Humidity –

20% to 80%

Operating

Compliances FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-

1998 STD, Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported

Windows 7 Professional 32-bit and 64-bit, Windows Vista® Business 32-bit and 64-bit, Windows® XP Professional, XP Professional 64-bit.

Not supported on Linux.



Technical Specifications - Networking and Communications

Integrated Intel 82579LM PCIe GbE Controller Connector RJ-45

Controller Intel 82579LM GbE platform LAN connect networking controller

Memory 24 KB FIFO packet buffer memory

Data Rates Supported 10/100/1000 Mbps

Compliance 802.1P, 802.1Q, 802.2, 802.3, 802.3ab, 802.3az, 802.3u

Bus Architecture PCI Express and SMBus

Data Transfer Mode PCIe-based interface for active state operation (S0 state) and SMBus

for host and management traffic (Sx low power state)

Power Requirement Requires 3.3V and 1.05V or just 3.3V with integrated regulators

Boot ROM Support Yes

Network Transfer Mode Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities

WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced

cable diagnostic.

AMT 7.0 support

Broadcom (5761) NetXtreme Gigabit Ethernet Plus NIC Connector RJ-45

Controller Broadcom 5761 PCI-Express LAN Controller

Memory 8 MB NVRAM serial Flash

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB, 802.3u, and 802.3x

Bus Architecture PCI-Express

Data Path Width Single Channel PCI-Express

Data Transfer Mode Bus Master DMA

Hardware FCC class B, Canada and US NRTL Mark, C-Tick for Australia, BSMI **Certifications** for Taiwan, VCCI for Japan, MIC for Korea, GOST for Russia, UL listed

(E212044), European Union Notice (CE 0682)

Power Requirement 1.8W @ 3.3V

Boot ROM Support Yes
Network Transfer Mode Full-duplex

Driver Support

Half-duplex (not available for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature32° to 131°F (0° to 55° C)

Operating Humidity 131° F (55° C) with 5% to 95% non-condensing humidity **Dimensions** 7 cm x 10.5 cm (2.75 in x 4.13 in), low profile compatible

Operating System Windows 7 Professional 32-bit and 64-bit, Windows Vista 32-bit SP1,

Windows Vista x64 SP1, Windows XP 32 bit professional, Windows XI

x64

Red Hat Enterprise Linux(RHEL) WS4*, 5, 6 Desktop/Workstation

Novell SLED 10 & 11



Technical Specifications - Networking and Communications

*RHEL WS4 not supported on Z200/Z200SFF

ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Broadcom mgmt utility, Management Capabilities ASF2.0, DASH 1.0 and DASH 1.1 profiles

Kit Contents Broadcom NetXtreme Gigabit Ethernet Plus NIC, Broadcom NetXtreme

Gigabit Ethernet Plus NIC USB Cable Assembly, CD, drivers, quick

install guide, product warranty statement

Intel Gigabit CT Desktop NIC

Connector **RJ-45**

Controller Intel WG82574L Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant,

802.3x flow control

Bus Architecture PCI-E 1.0a

Data Path Width X1, 250 MB/s, Bi-directional interface

Data Transfer Mode Bus-master DMA

Hardware FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS

Certifications Mark for European Union

Power Requirement Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM Support

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131°F (0° to 55° C) **Operating Humidity** 85% at 131° F (55° C)

Dimensions 12.1 x 5.7 x 2.0 cm (4.75 x 2.25 x 0.8 in)

Operating System **Driver Support**

Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64 Windows Vista Business 32, Windows XP Professional, Windows XP

x64.

Red Hat Enterprise Linux 4 (RHEL4.8 or newer)*, Red Hat Enterprise

Linux 5 (RHEL5.3 or newer), Red Hat Enterprise Linux 6

* RHEL WS4 not supported on Z200/Z200SFF

Management

Capabilities

WOL, PXE, DMI, WFM 2.0

Kit Contents Intel Gigabit CT Desktop NIC, low profile bracket, CD containing Intel

PROset II NIC drivers, quick install guide, product warranty statement

Technical Specifications - Networking and Communications

HP NC360T PCI Express Dual Port Gigabit NIC ConnectorTwo RJ-45ControllerIntel 82571EBMemoryIntegrated 96KBData Rates Supported10/100/1000 Mbps

Compliance 802.3, 802.3u, 802.3x, 802.3ab, 802.3ad, 802.1p, 802.1Q

Bus Architecture PCI-E 1.0a

Data Path Width Four lane (x4) PCI Express compatible with x4, x8, and x16 PCI

Express slots

Data Transfer Mode Bus-master DMA

Hardware FCC Class B, VCCI Class B, BSMI Class A, CISPR 22 Class B, EN **Certifications** 55022 Class B, EN55024-1, ICES-003 Class B, MIC Class B, ACA

Class B, UL, Canada UL, EN60950

Power Requirement 1280 mA @ 3.3V typical

Boot ROM Support Yes

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature32° to 131°F (0° to 55° C)
Operating Humidity 0% to 95% non-condensing
Dimensions 12.95 x 6.8 cm (5.1 x 2.7 in)

Operating System Wind Driver Support Profe

Windows Vista Business 64, Windows Vista Business 32, Windows X

Professional, Windows XP Professional x64 Edition.

Red Hat Enterprise Linux(RHEL) WS4, 5, 6 Desktop/Workstation

Novell SLED 10 & SLED 11

Management Capabilities

WOL, PXE 2.1

Kit Contents HP NC360T PCI Express Dual Port Gigabit NIC, low profile bracket, CI

containing Intel PROset II NIC drivers, quick install guide, product

warranty statement

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